

# RZ SMARC Series Carrier Board

User's Manual: Hardware

Renesas Microprocessor  
RZ Family / RZ/G, RZ/V, RZ/A Series

RTK97X4XXB00000BE

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## General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

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### 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

### 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

### 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

### 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

### 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

### 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

### 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

### 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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## 1. Overview

### 1.1 Overview

This document describes the specification of RTK97X4XXXB00000BE which is a Carrier board for use with to a Module board. In combination with the Module board, device functionality and performance can be evaluated, and application software can be developed and evaluated in advance.

The RTK97X4XXXB00000BE complies with the SMARC v2.1 and has following features.

- The FFC/FPC connector is mounted as standard for connection to high-speed serial interface for camera module.
- The microHDMI connector via MIPI-DSI to HDMI transceiver is mounted as standard for connection to high-speed serial interface for digital video module.
- The microUSB Type-AB receptacle (ch0: USB2.0 Host-Function) and USB Type-A receptacle (ch1: USB2.0 Host) are respectively mounted as standard for connection to USB interface.
- The RJ45 connector is mounted as standard for software development and evaluation using Ethernet.
- The audio codec is mounted as standard for advance development of audio system. The audio input/output jack is implemented for connection to audio interface.
- The microUSB Type-AB receptacles is implemented for connection to asynchronous serial port interface.
- The microSD card slot and two sockets for PMOD are implemented as an interface for peripheral functions.
- For power supply, it is mounted a USB Type-C receptacle that supports the USB PD standard.

#### NOTE

The CAN connector is implemented, but CAN-FD interface cannot be used because a CAN transceiver is not fitted.

The following Carrier boards are equipped with a CAN transceiver and CAN-FD interface is available already.

S.LOT# on the outer box label: 000251812 or later

S.LOT# label on the Carrier board: 251812 or later

## 1.2 Configuration

**Figure 1.1** shows an example of system configuration using the RTK97X4XXXB00000BE. Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board(\*1).

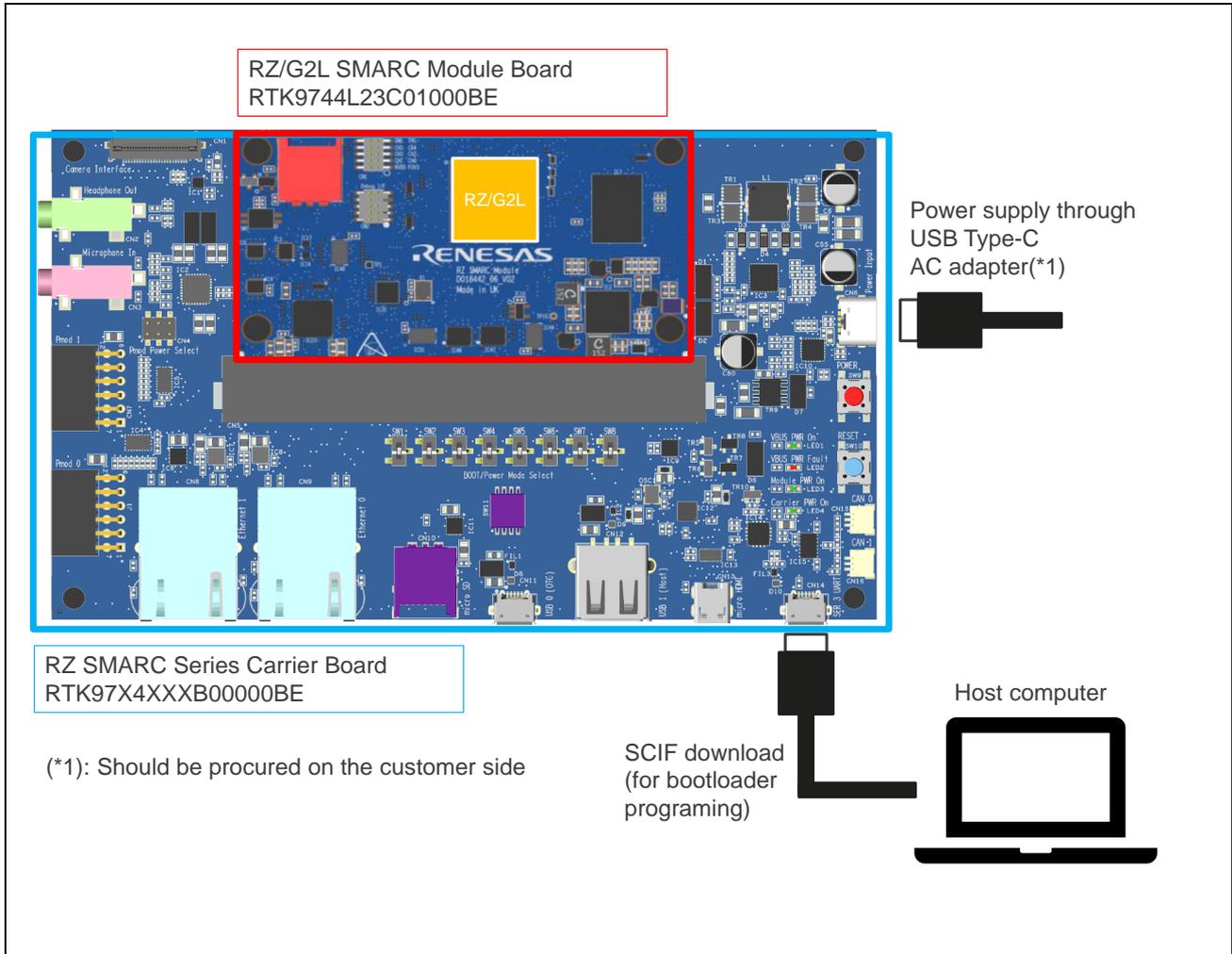


Figure 1.1 Example of System Configuration Using the RTK97X4XXXB00000BE

**Note 1.** The targeted Module Board is below:

- RTK9744C22C01000BE (RZ/G2LC SMARC Module Board)
- RTK9754L23C01000BE (RZ/V2L SMARC Module Board)
- RTK9743U11C01000BE (RZ/G2UL SMARC Module Board)
- RTK9743F01C01000BE (RZ/Five SMARC Module Board)
- RTK9763U02C01000BE (RZ/A3UL SMARC Module Board QSPI Edition)
- RTK9763U02C01001BE (RZ/A3UL SMARC Module Board OCTAL Edition)

## 1.3 Features

**Table 1.1** shows the features of the RTK97X4XXXB00000BE.

Table 1.1 Features of the RTK97X4XXXB00000BE

| Item                         | Details  |
|------------------------------|--|
| Video IC                     | MIPI-DSI to HDMI transceiver: 1pc  |
| Codec IC                     | Audio codec: 1pc   |
| Connector                    | SMARC edge connector (314 pins): 1pc<br>Audio input/output jack: 2pcs<br>Serial port connector (microUSB Type-AB): 1pc<br>LAN connector (RJ-45): 2pcs<br>microSD card slot (4 bits): 1pc<br>USB Type-A receptacle: 1pc<br>microUSB Type-AB receptacle: 1pc<br>MIPI CSI-2 camera connector: 1pc<br>microHDMI connector: 1pc<br>PMOD connector: 2pcs<br>USB Type-C receptacle: 1pc |
| Switch                       | Power switch: 1pc<br>Reset switch: 1pc<br>System setting DIP switch: 4 bits<br>I/F setting DIP switch: 8pcs  |
| Circuit board specifications | Dimensions: 160 mm * 100 mm<br>Mount: Single-sided mounting (6 layers)   |

## 1.4 Physical View

Figure 1.2 and Figure 1.3 show the outside view of the RTK97X4XXXB00000BE.

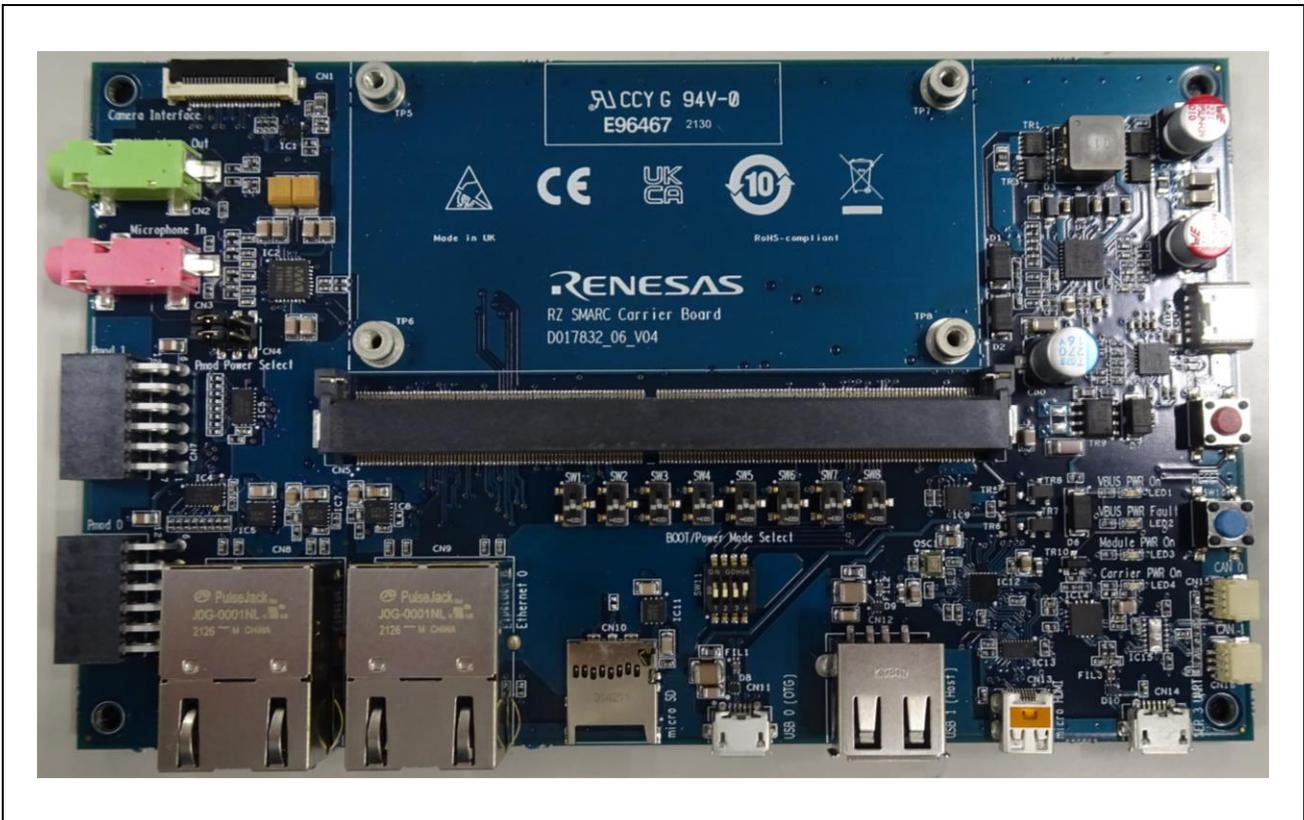


Figure 1.2 Top View of the RTK97X4XXXB00000BE

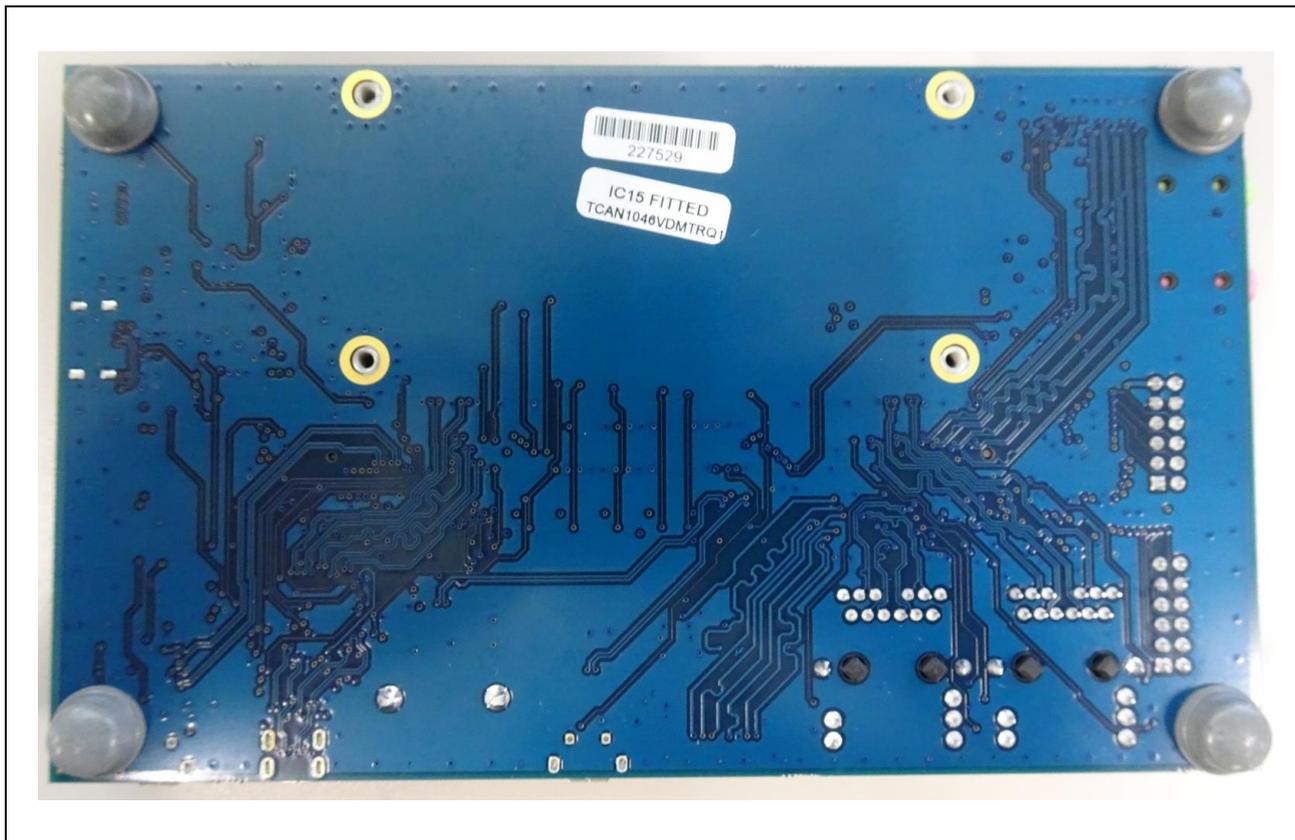


Figure 1.3 Bottom View of the RTK97X4XXB00000BE

### 1.5 Block Diagram

Figure 1.4 shows the block diagram of the RTK97X4XXXB00000BE.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

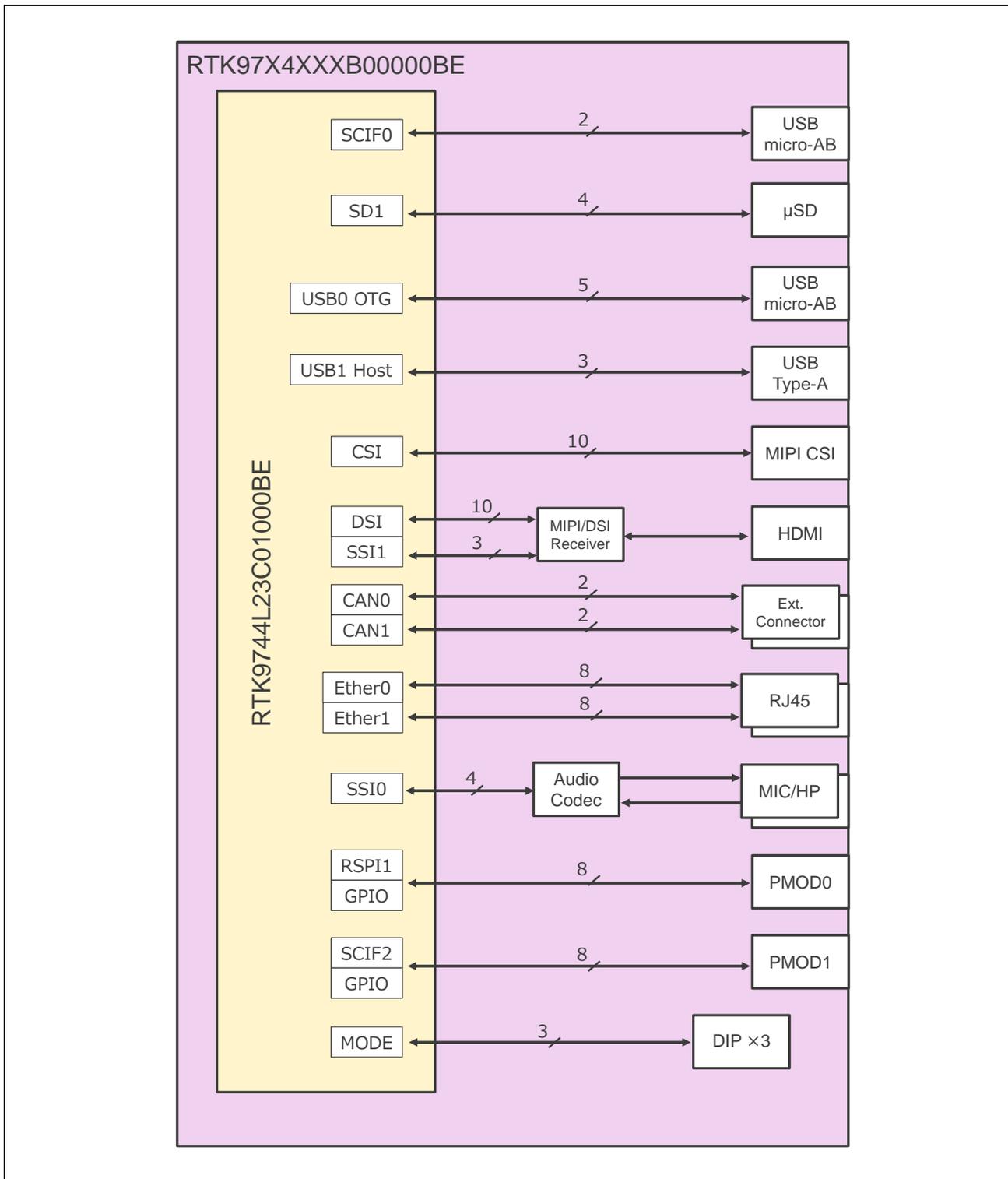


Figure 1.4 Block Diagram of the RTK97X4XXXB00000BE

## 1.6 Layout Components

Figure 1.5 and Figure 1.6 show the layout of main components of the RTK97X4XXXB00000BE.

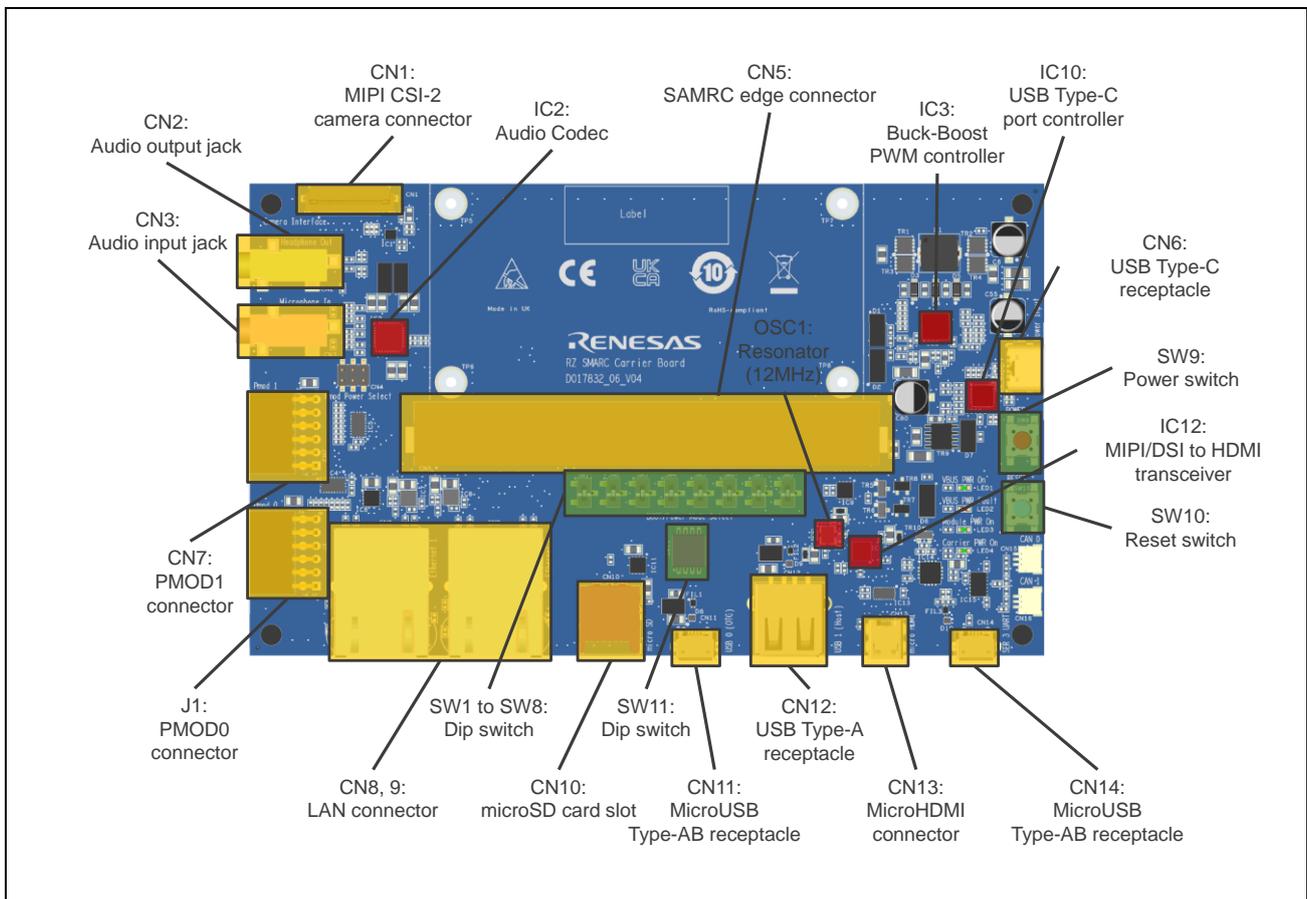


Figure 1.5 Layout of Components of the RTK97X4XXXB00000BE (Top View)

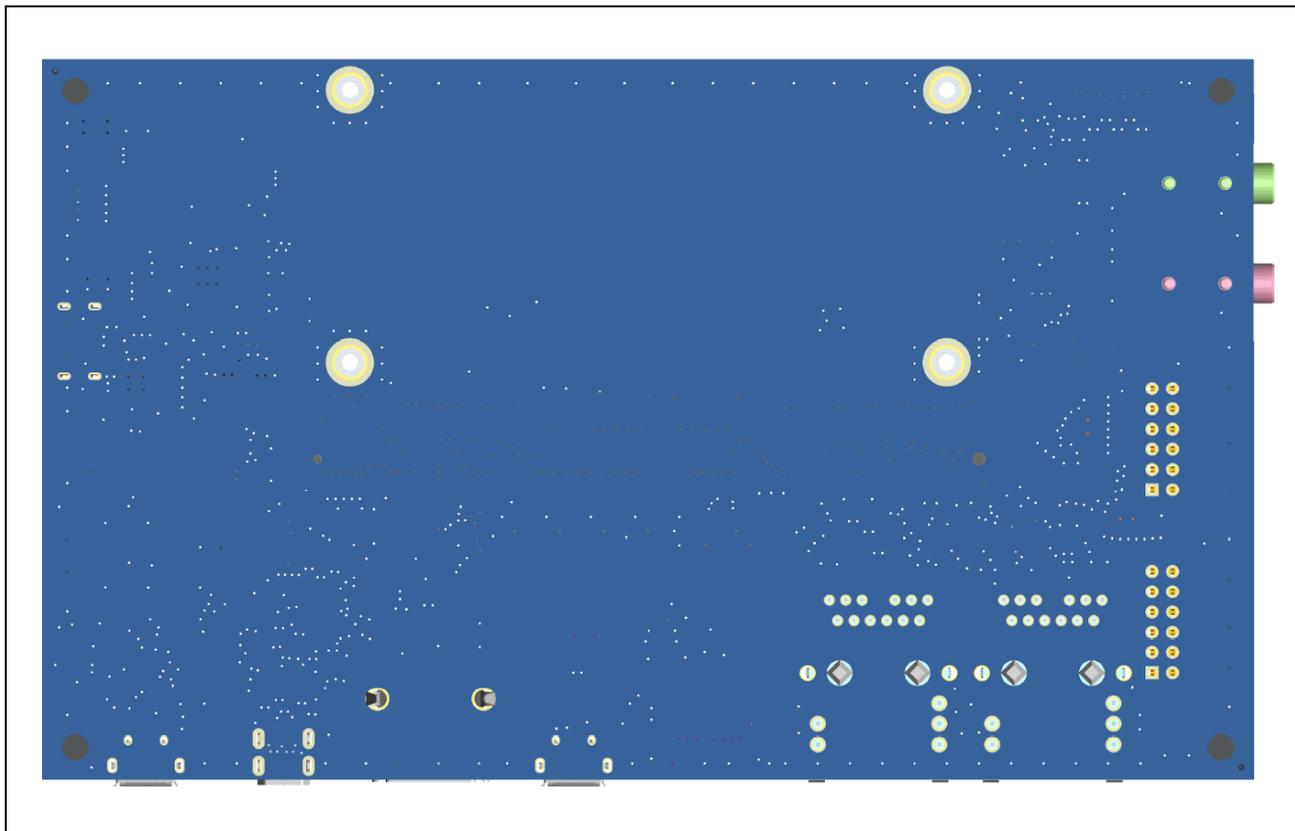


Figure 1.6 Layout of Components of the RTK97X4XXXB00000BE (Bottom View)

**Table 1.2** and **Table 1.3** list main components mounted on the RTK97X4XXB00000BE.

Table 1.2 Main Components on the RTK97X4XXB00000BE (1) IC

| Component Number | Component Name                         | Type (Manufacturer)                     | Recommended Optional Components |
|------------------|--|---|---------------------------------|
| IC2              | Audio Codec                            | WM8978CGEFL/V<br>(Wolfson Cirrus Logic) |                                 |
| IC3              | Buck-Boost PWM controller              | ISL81401FRZ<br>(Renesas Electronics)    |                                 |
| IC10             | USB Type-C port controller             | CYPD3177-24LQXQ<br>(Cypress)            |                                 |
| IC12             | MIPI-DSI to HDMI transceiver           | ADV7535BCBZ-RL<br>(Analog Devices)      |                                 |
| OSC1             | Crystal resonator for HDMI transceiver | SIT1602AI-23-18E-12.000000D<br>(SiTime) | 12MHz                           |

Table 1.3 Main Components on the RTK97X4XXB00000BE (2) Connector

| Components Number | Component Name                | Type (Manufacturer)                | Recommend Optional Parts |
|-------------------|-------------------------------|------------------------------------|--------------------------|
| CN1               | MIPI CSI-2 camera connector   | 5051102491 (Molex)                 |                          |
| CN2               | Audio output jack             | SJ-3524-SMT-TR-GR<br>(CUI Devices) |                          |
| CN3               | Audio input jack              | SJ-3524-SMT-TR-PI<br>(CUI Devices) |                          |
| CN5               | SMARC edge connector (314pin) | MM70-314B1-2-R300 (JAE)            |                          |
| CN6               | USB Type-C receptacle         | UJC-HP-3-SMT-TR (CUI Devices)      |                          |
| J1, CN7           | PMOD0/1 connector             | SSW-106-02-T-D-RA (Samtec)         |                          |
| CN8, CN9          | LAN connector                 | J0G-0001NL (Pulse Electronics)     |                          |
| CN10              | MicroSD card slot             | 504077-1891 (Molex)                |                          |
| CN12              | USB Type-A receptacle         | KUSBX-SMT-AS1N-B (Kycon)           |                          |
| CN11, CN14        | MicroUSB Type-AB Receptacle   | 629105150921 (We-online)           |                          |
| CN13              | MicroHDMI connector           | 46765-1301 (Molex)                 |                          |

## 1.7 Absolute Maximum Ratings

**Table 1.4** lists absolute maximum ratings of the RTK97X4XXXB00000BE.

Table 1.4 Absolute Maximum Ratings of the RTK97X4XXXB00000BE

| Symbol       | Item                            | Rated Value   | Note   |
|--------------|---------------------------------|---------------|--|
| USBC_VBUS_IN | Power voltage                   | 30V           | Reference: USB Type-C Port Controller (CYPD3177) Specification |
| —            | Maximum power consumption       | 3A            | Includes continuous RZ/G2L Module Board current consumptions   |
| Topr         | Operating ambient temperature*1 | 0°C to 50°C   | Do not expose to condensation or corrosive gases               |
| Tstg         | Storage temperature*1           | -10°C to 60°C | Do not expose to condensation or corrosive gases               |

Note 1. Ambient temperature is the air temperature at a position as close to the board as possible.

## 1.8 Operating Condition

**Table 1.5** lists operating conditions of the RTK97X4XXXB00000BE.

Table 1.5 Operating Conditions of the RTK97X4XXXB00000BE

| Symbol       | Item                            | Rated Value   | Note  |
|--------------|---------------------------------|---------------|---|
| USBC_VBUS_IN | Power voltage                   | 4.5V to 12.5V | Reference: Vss  |
| —            | Maximum consumption current     | 2A            | In the case of 5V input voltage<br>Includes continuous RZ/G2L Module Board current consumptions |
| Topr         | Operating ambient temperature*1 | 0°C to 40°C   | Do not expose to condensation or corrosive gases  |

Note 1. Ambient temperature is the air temperature at a position as close to the board as possible.

## 2. Functional Specifications

### 2.1 Overview of Functions

**Table 2.1** lists function modules of the RTK97X4XXXB00000BE.

Table 2.1 Function Modules of the RTK97X4XXXB00000BE

| Section     | Function                          | Description   |
|-------------|-----------------------------------|---|
| <b>2.2</b>  | <b>MPU</b>                        | Devices pin functions used in the RTK97X4XXXB00000BE  |
| <b>2.3</b>  | <b>USB Interface</b>              | Connection between the USB2.0 host/function module and microUSB Type-AB, Type-A connector               |
| <b>2.4</b>  | <b>Gigabit Ethernet Interface</b> | Connection between the Ethernet controller (E-MAC) and LAN connector via Ethernet PHY                   |
| <b>2.5</b>  | <b>Serial Interface</b>           | Connection between the Serial Communications Interface with FIFO (SCIFA) and microUSB Type-AB connector |
| <b>2.6</b>  | <b>Clock Configuration</b>        | System clock configuration  |
| <b>2.7</b>  | <b>Reset Control</b>              | Reset control for the Module board and devices installed on RTK97X4XXXB00000BE.                         |
| <b>2.8</b>  | <b>Power Supply Configuration</b> | System power supply configuration of the Module board and RTK97X4XXXB00000BE                            |
| <b>2.9</b>  | <b>SD1 Interface</b>              | Connection between the SD/MMC Host Interface (SDHI) channel 1 and microSD card slot                     |
| <b>2.10</b> | <b>Audio Interface</b>            | Connection for the Serial Sound Interface (SSIF-2) via Audio Codec (WM8978)                             |
| <b>2.11</b> | <b>Camera Interface</b>           | Connection between the Camera Data Receiving Unit (CRU) and camera connector                            |
| <b>2.12</b> | <b>Display Interface</b>          | Connection between devices and microHDMI connector via the MIPI/DSI to HDMI transceiver                 |
| <b>2.13</b> | <b>CAN-FD Interface</b>           | Connection between the CAN-FD interface (RS-CANFD) and CAN connector                                    |
| <b>2.14</b> | <b>PMOD Interface</b>             | Connection between General Purpose Input Output interface (GPIO) and PMOD connector                     |
| —           | Operating specification           | Connectors, switches and LEDs<br>Details are described in Chapter 3                                     |

### 2.2 MPU

Please refer to the function list (section 2.2.2) in the user's manual of each module board.

## 2.3 USB Interface

### 2.3.1 USB0 (Host-Function)

Figure 2.1 shows a block diagram of the USB0 (Host-Function) interface.

The RTK97X4XXXB00000BE is implemented the VBUS supply circuit, a protection diode and the microUSB Type-AB receptacle.

This interface complies with the USB standard version 2.0 and supports the USB On-The-Go function.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

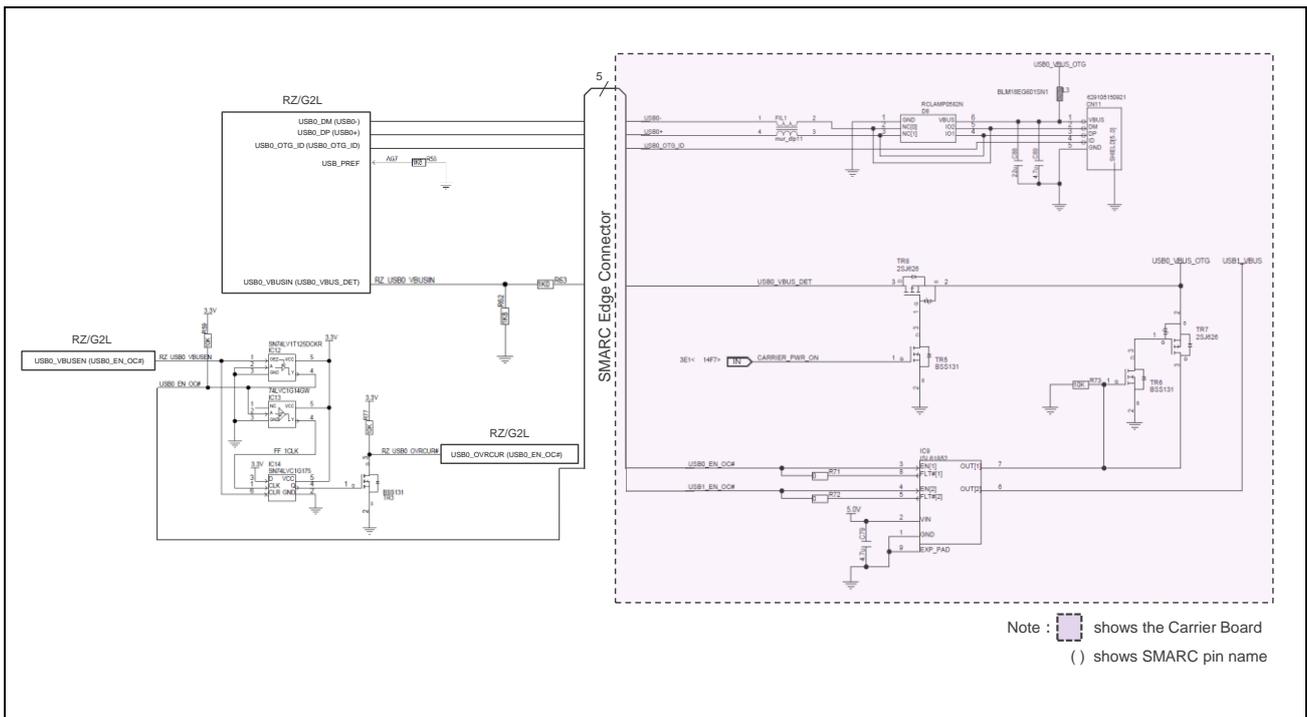


Figure 2.1 Block Diagram of USB0 (Host-Function) I/F



## 2.4 Gigabit Ethernet Interface

Figure 2.3 and Figure 2.4 show a block diagram of Gigabit Ethernet0 and Ethernet1 interface.

The RTK97X4XXXB00000BE is implemented the RJ45 connector for connection to the Ethernet interface.

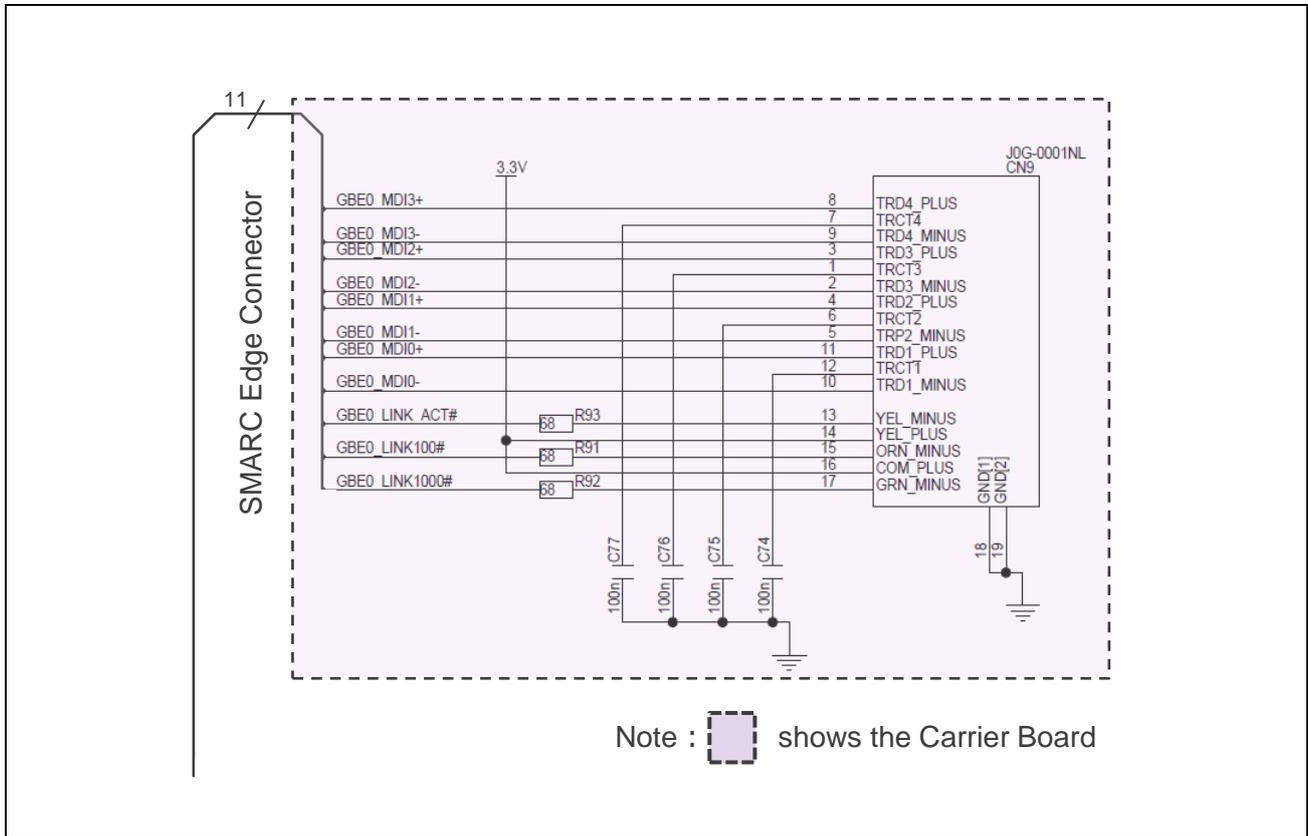


Figure 2.3 Block Diagram of Gigabit Ethernet0 I/F

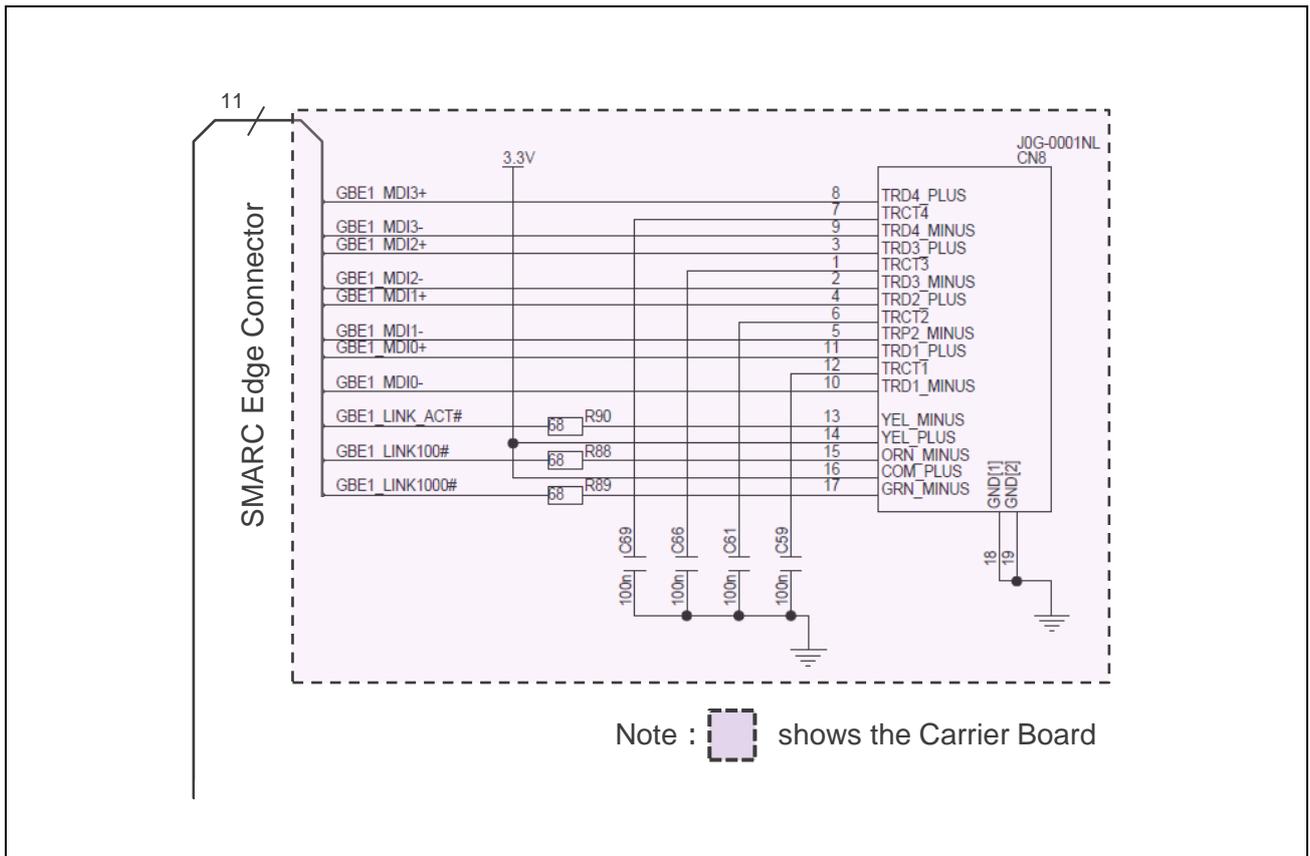


Figure 2.4 Block Diagram of Gigabit Ethernet1 I/F

## 2.5 Serial Interface

Figure 2.5 shows a block diagram of Serial interface.

The RTK97X4XXXB00000BE is connected the microUSB Type-AB receptacle through the USB serial conversion IC. The six input channels can be used.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

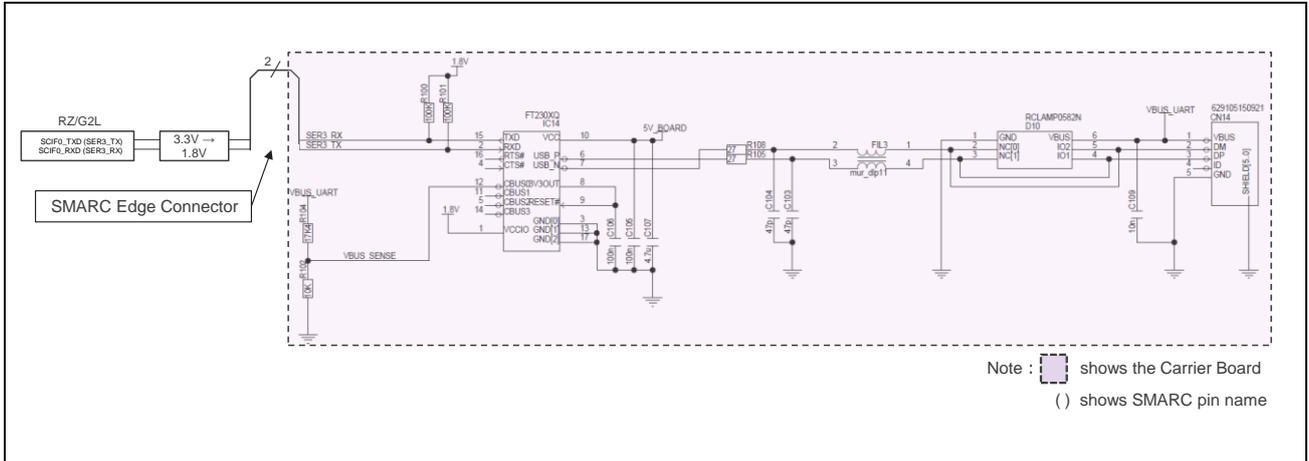


Figure 2.5 Block Diagram of Serial I/F

## 2.6 Clock Configuration

Figure 2.6 shows a block diagram of the Clock configuration.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

**NOTE**

MIPI-DSI Interface supports operation up to Full HD, 60fps mode.

SD Interface supports UHS-I mode of 50MB/s (SDR50) and 104MB/s (SDR104).

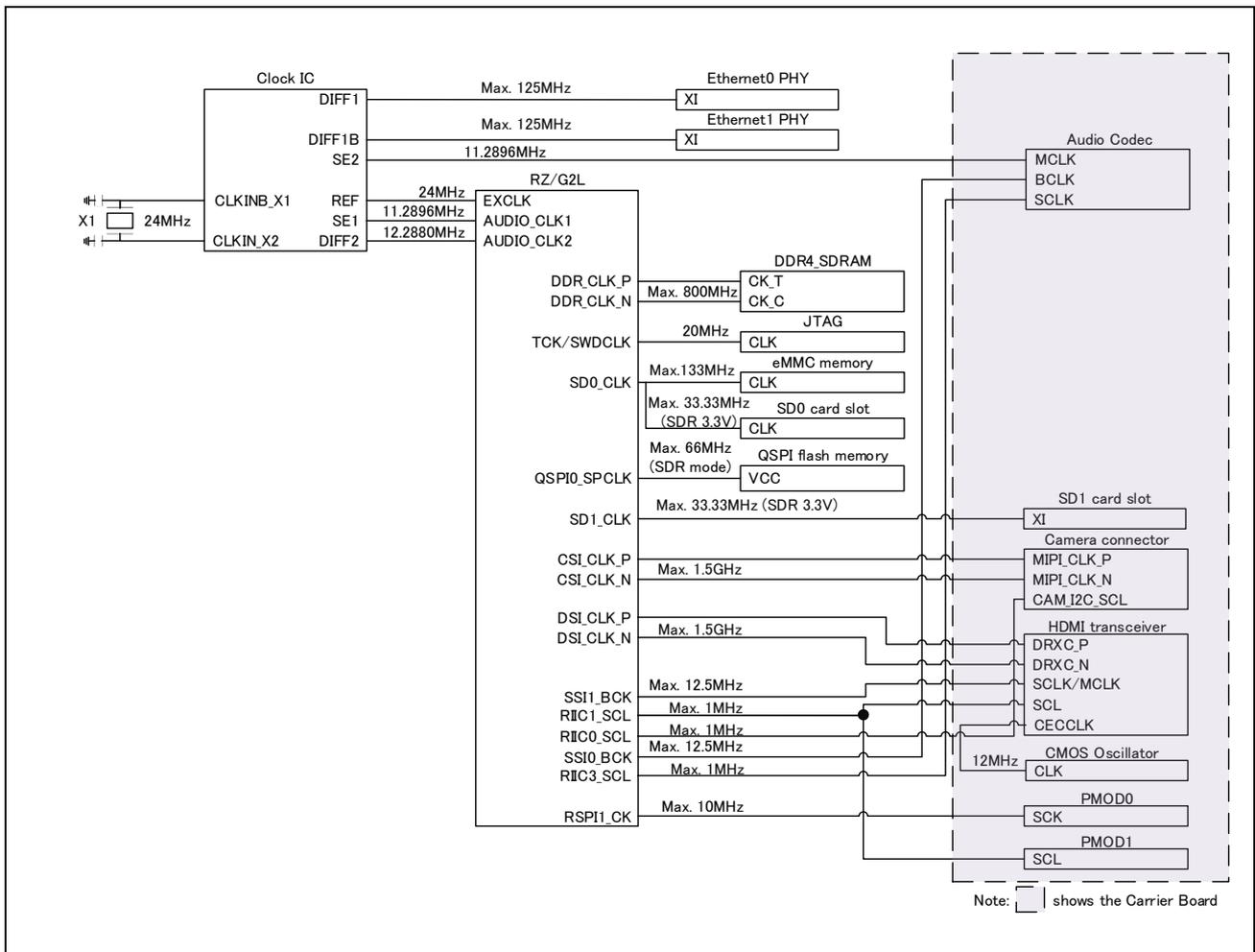


Figure 2.6 Block Diagram of Clock Configuration

## 2.7 Reset Control

Figure 2.7 shows block diagrams of a reset control for the RTK9744L23S01000BE (Evaluation board Kit for RZ/G2L MPU).

For the RTK97X4XXXXB00000BE, the interfaces of PMOD and Camera are controlled by reset signal from the PMIC.

There are two types of system resets: power-on reset and reset by the button switch.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

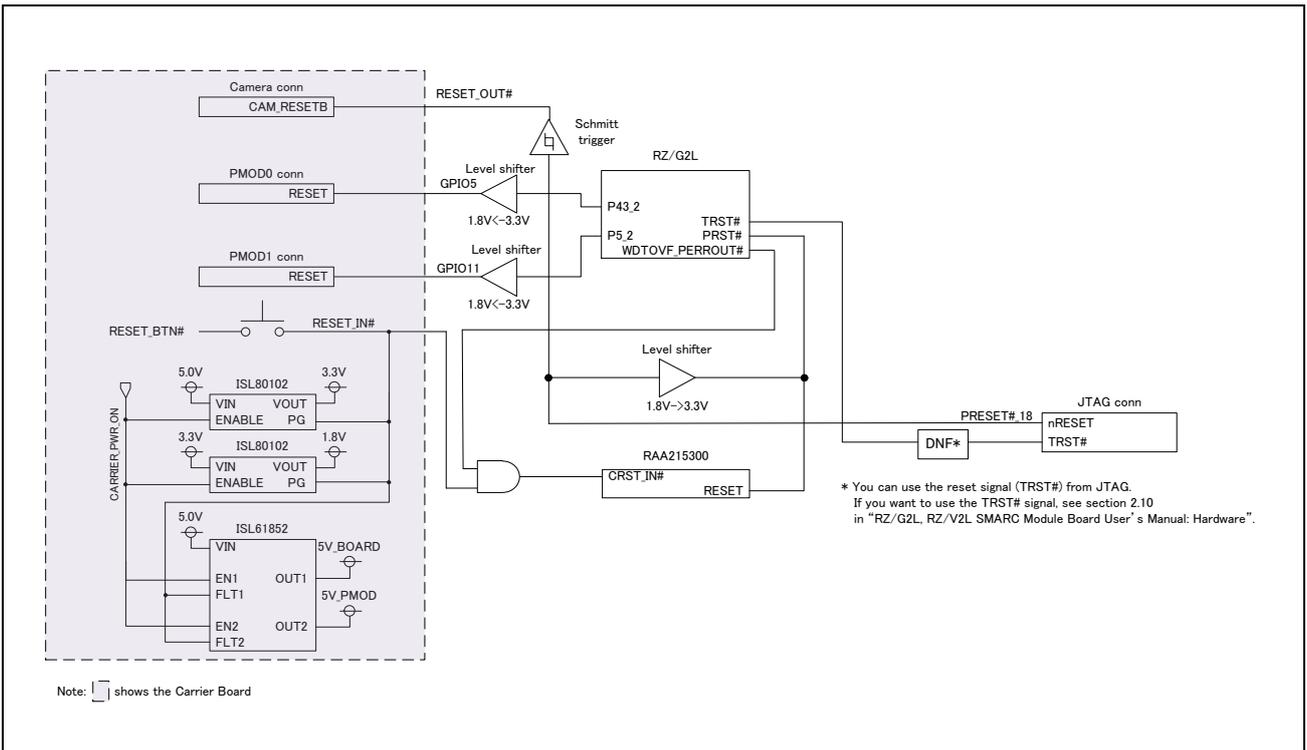


Figure 2.7 Block Diagram of Reset Control

## 2.8 Power Supply Configuration

**Figure 2.8** shows a block diagram of power configuration for the RTK9744L23S01000BE (Evaluation board Kit for RZ/G2L MPU).

This board has a USB Type-C receptacle for power input with USB Power Delivery. The input voltage of VBUS can be selected between 5V and 9V.

The default setting for controlling the input voltage level is 5V (max 3A input) with SW11-4 is turned on. When the switch is turned off, the input voltage is 9V (max 3A input). Only when the RTK9744L23S01000BE is connected to external devices that requires a lot of power and is expected to run out of power, the SW 11-4 is turned off.

The 5V power supply is supplied to the PMIC installed in the RTK9744L23C01000BE, and the PMIC generates the power supply voltage for each interface.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

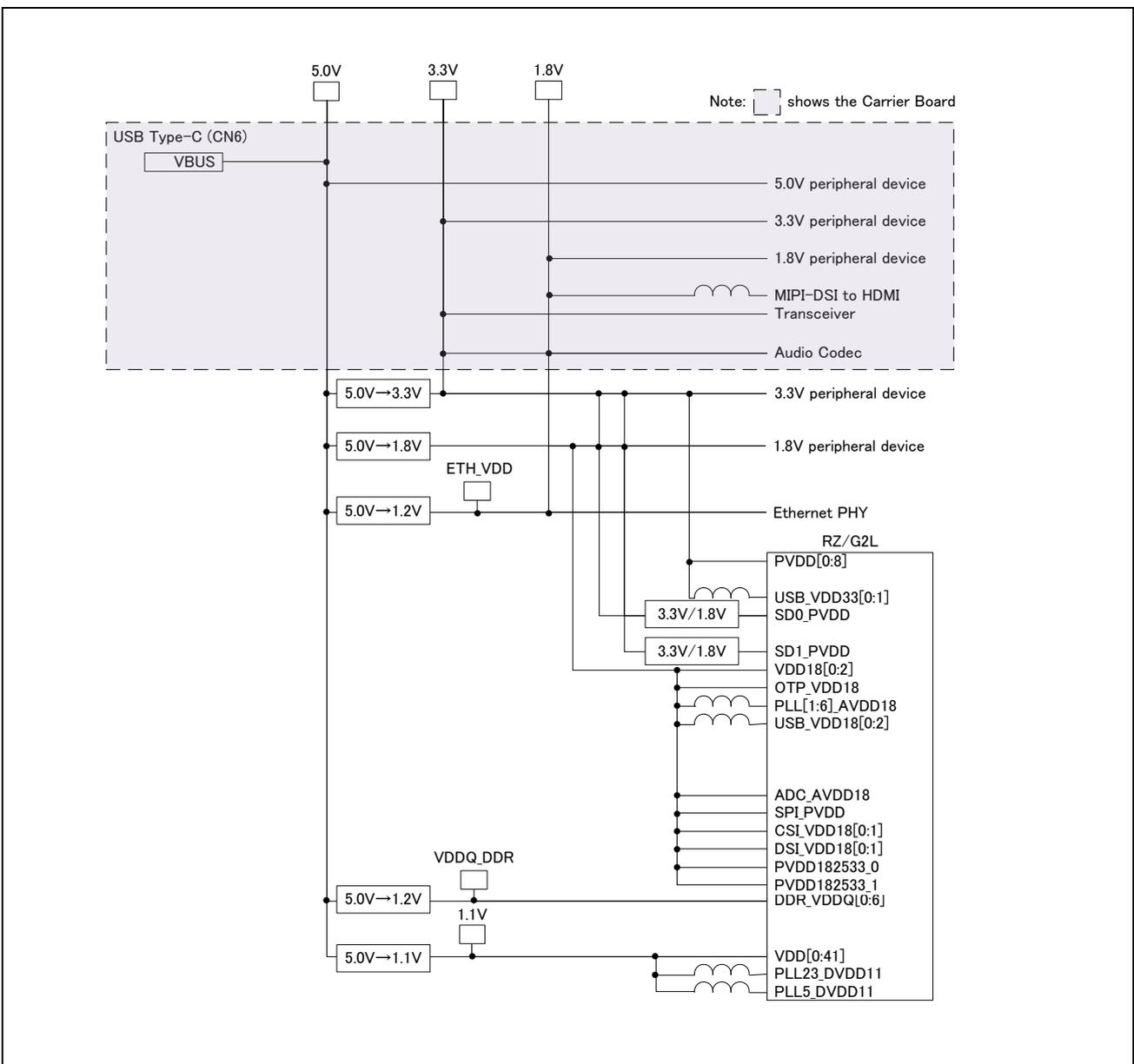


Figure 2.8 Block Diagram of Power Configuration

Figure 2.9 shows a block diagram of a power regulation for the RTK97X4XXXB00000BE.

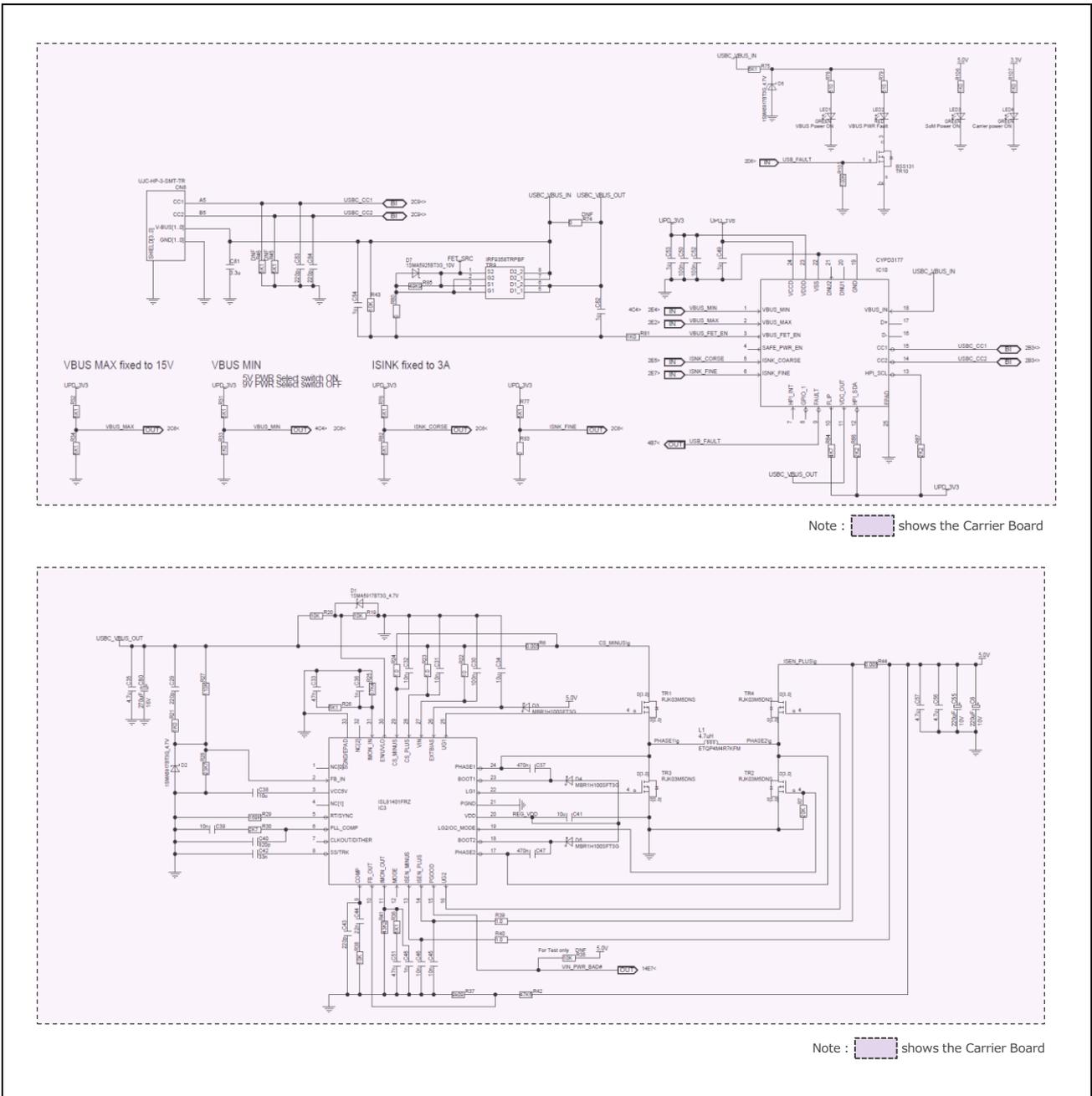


Figure 2.9 Block Diagram of Power Regulation

## 2.9 SD1 Interface

Figure 2.10 shows a block diagram of the SD1 interface.

The RTK97X4XXXB00000BE is implemented a microSD card socket and connected to channel1 of SD interface with built-in RZ/G2L.

This interface complies with the memory card standard version 3.0 and supports the UHS-I mode of 50MB/s (SDR) and 104MB/s (SDR104).

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

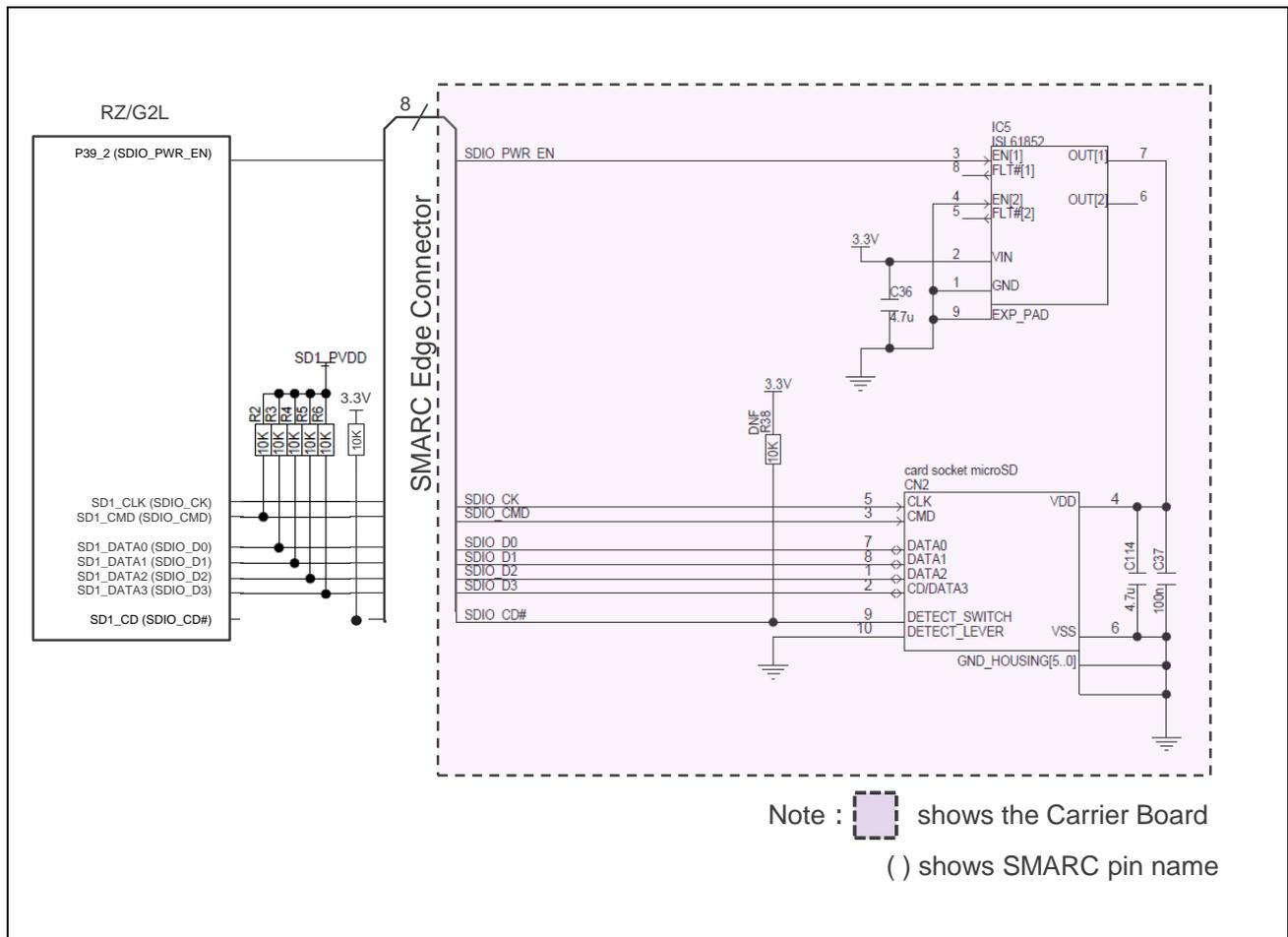


Figure 2.10 Block Diagram of SD1 I/F

## 2.10 Audio Interface

Figure 2.11 shows a block diagram of the Audio interface.

The RTK97X4XXXB00000BE is connected a connector through the Audio Codec. This interface supports I2S/monaural formats.

The Audio data input/output is controlled with the serial sound interface (SSIF-2) with built-in RZ/G2L.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

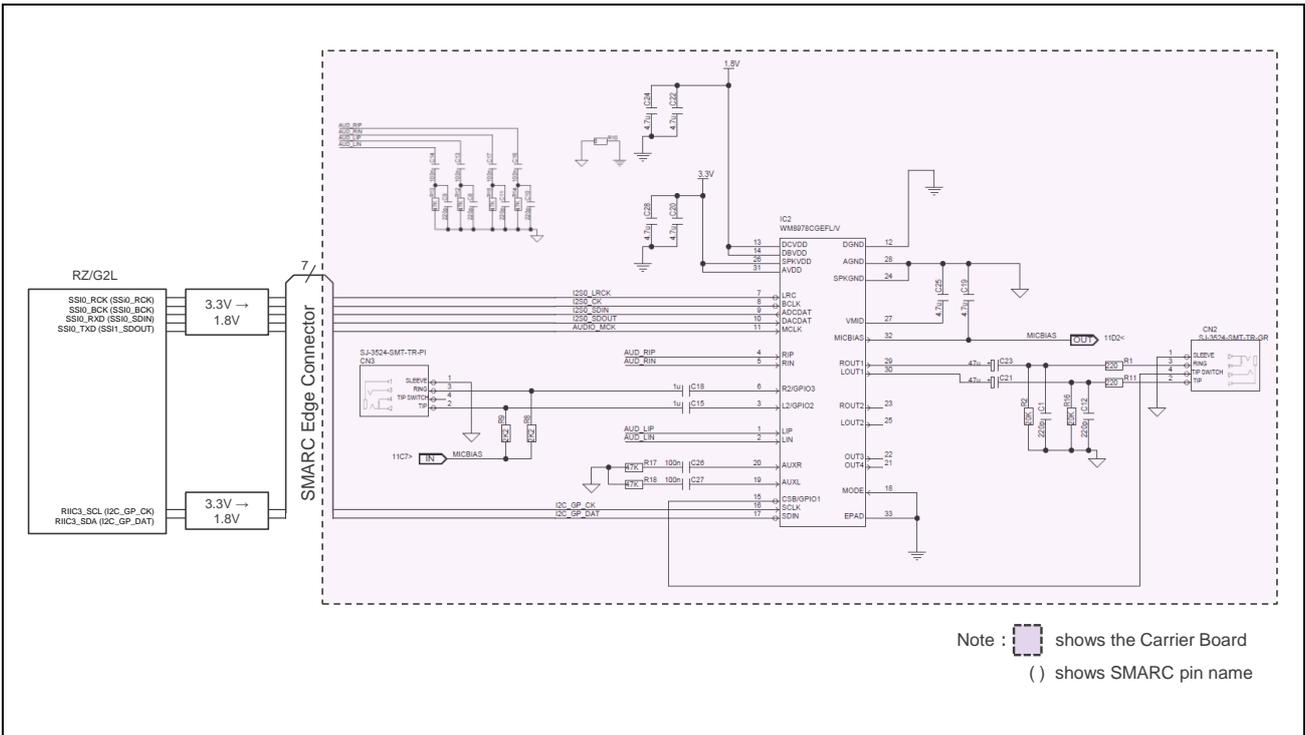


Figure 2.11 Bloc Diagram around Audio I/F

## 2.11 Camera Interface

Figure 2.12 shows a block diagram of the Camera interface.

The RTK97X4XXXB00000BE is implemented the FFC/FPC connector for connection to the MIPI CSI-2. This interface supports a maximum resolution 5MP/30fps.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

When using the Camera interface, please be sure to connect camera modules when the power is off. Reset release is not done properly when the power is switched on.

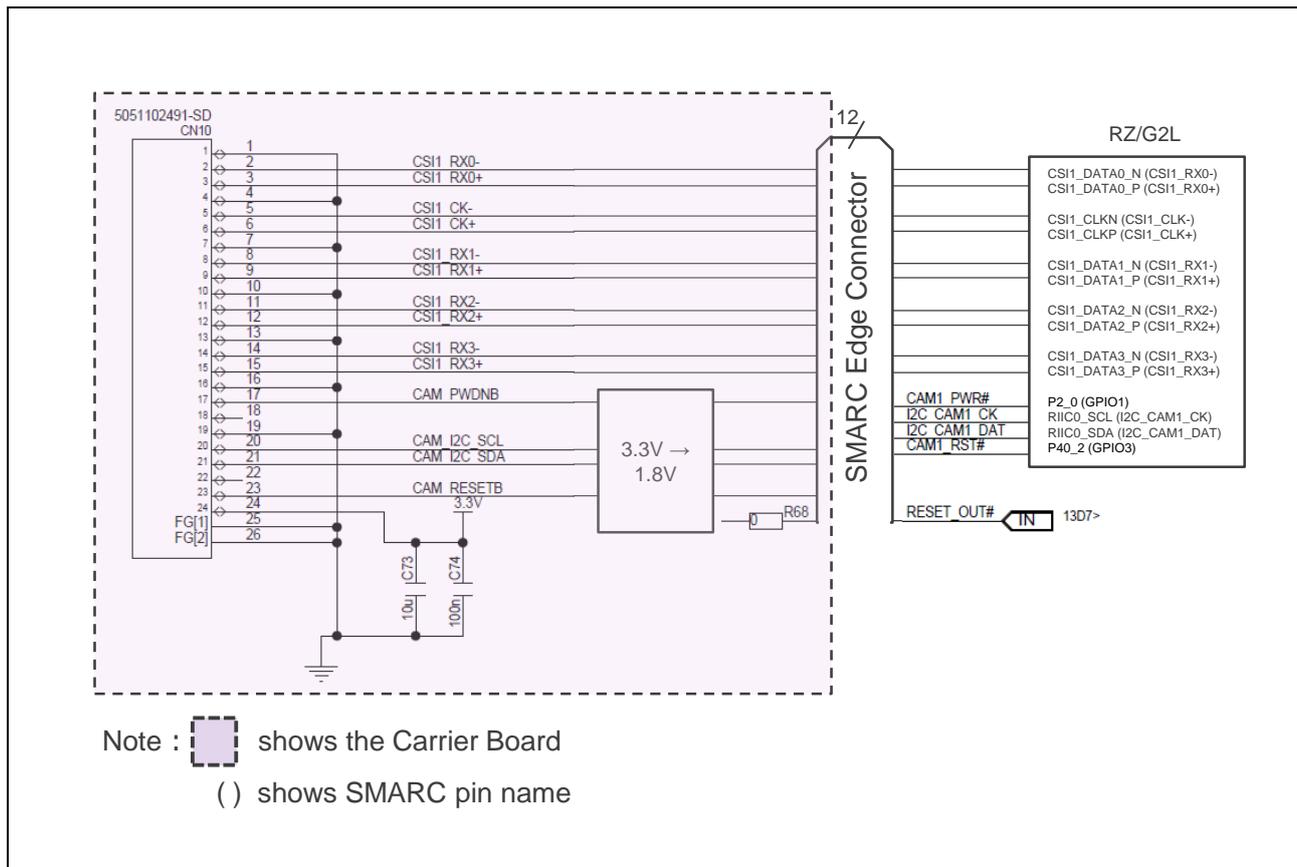


Figure 2.12 Block Diagram of Camera I/F

## 2.12 Display Interface

Figure 2.13 shows a block diagram of the Display (MIPI-DSI to HDMI) interface.

The RTK97X4XXXB00000BE is connected a microHDMI connector through the MIPI-DSI to HDMI transceiver. This interface supports Full HD and 60fps.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

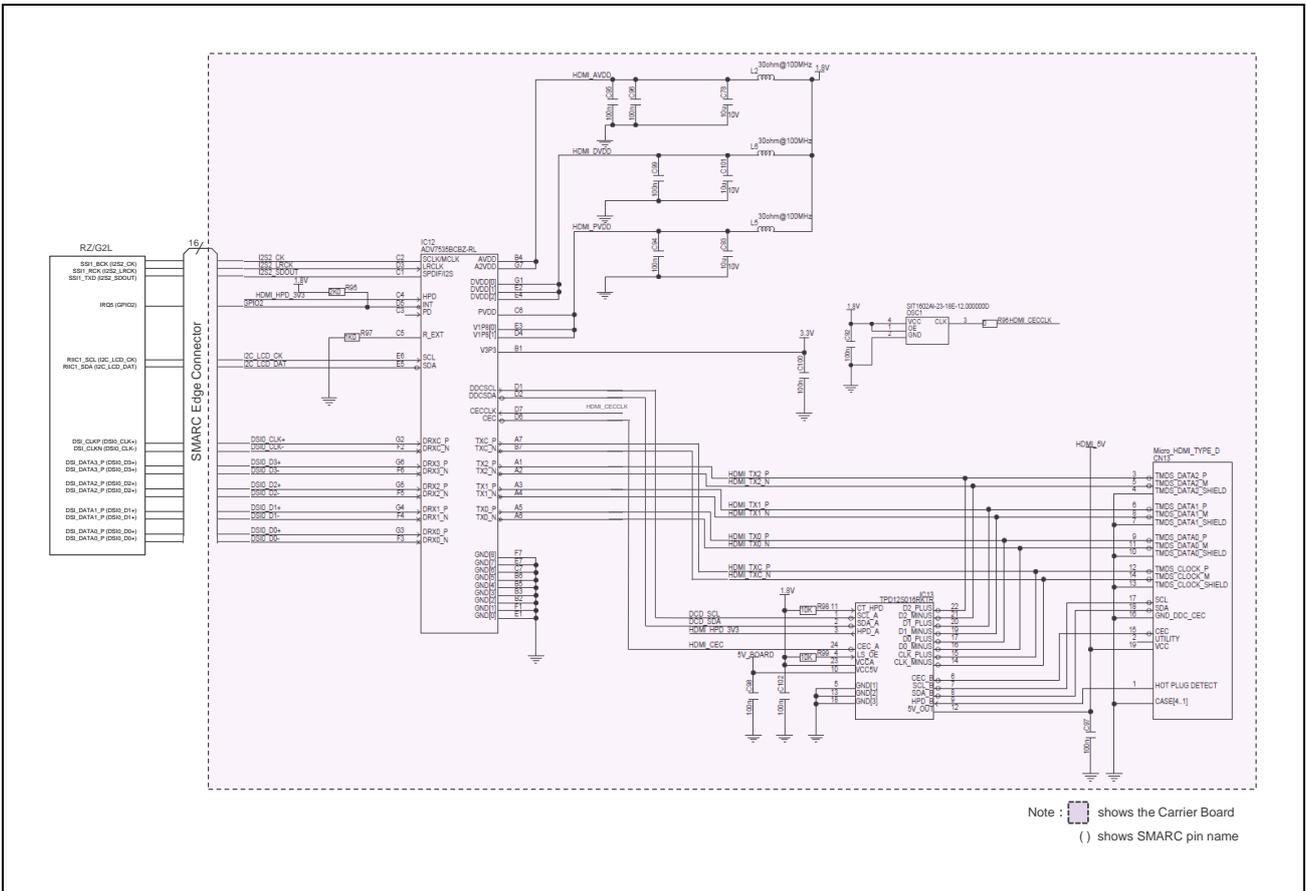


Figure 2.13 Block Diagram of Display I/F

### 2.13 CAN-FD Interface

Figure 2.14 shows a block diagram of the CAN-FD interface.

The RTK97X4XXXB00000BE is connected the CAN0 and CAN1 connector through the CAN0 and CAN1 transceiver. This interface complies with ISO 11898-1 (2003) and CAN-FD interface complies with ISO 11898-1 (CD2014).

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

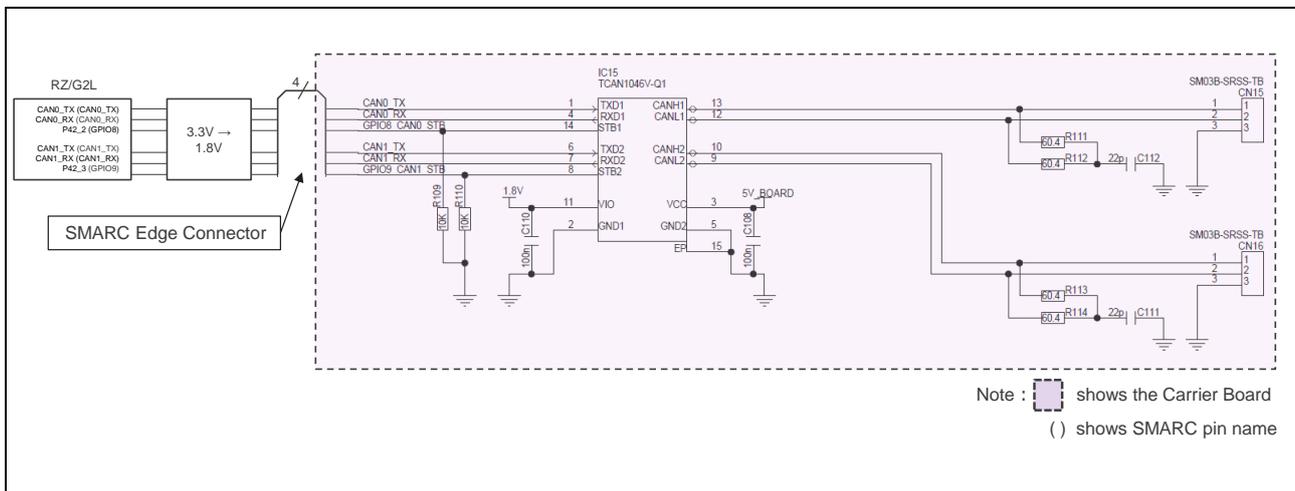


Figure 2.14 Block Diagram of CAN-FD I/F

## 2.14 PMOD Interface

Figure 2.15 shows a block diagram of the PMOD interface.

The RTK97X4XXXB00000BE is implemented a Type2A PMOD module. The Type2A interface provides a SPI interface plus additional control signals. There is also a 5V power source option.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

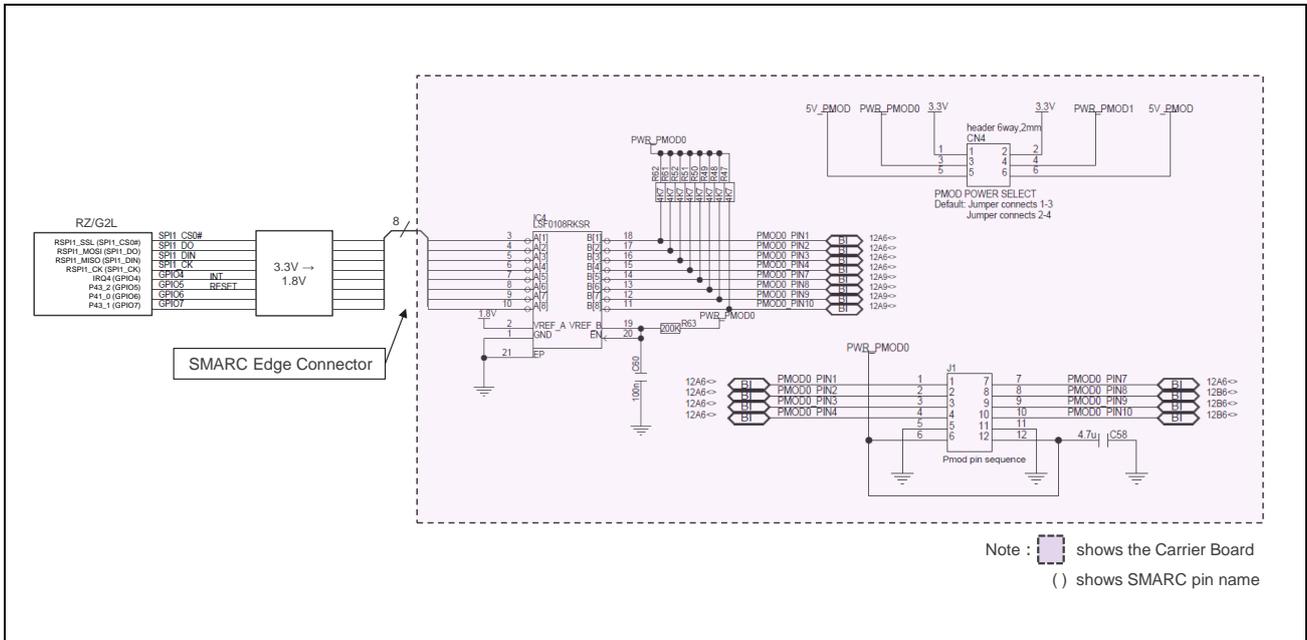


Figure 2.15 Block Diagram of PMOD0 I/F

Figure 2.16 shows a block diagram of the PMOD interface.

The RTK97X4XXXB00000BE is implemented a Type3A&Type6A PMOD module. The Type3A interface provides a UART interface with optional hardware flow control plus additional control signals. The Type6A interface provides an I2C interface. There is also a 5V power source option.

Here, it shows an example that the RTK9744L23C01000BE is used as the Module Board.

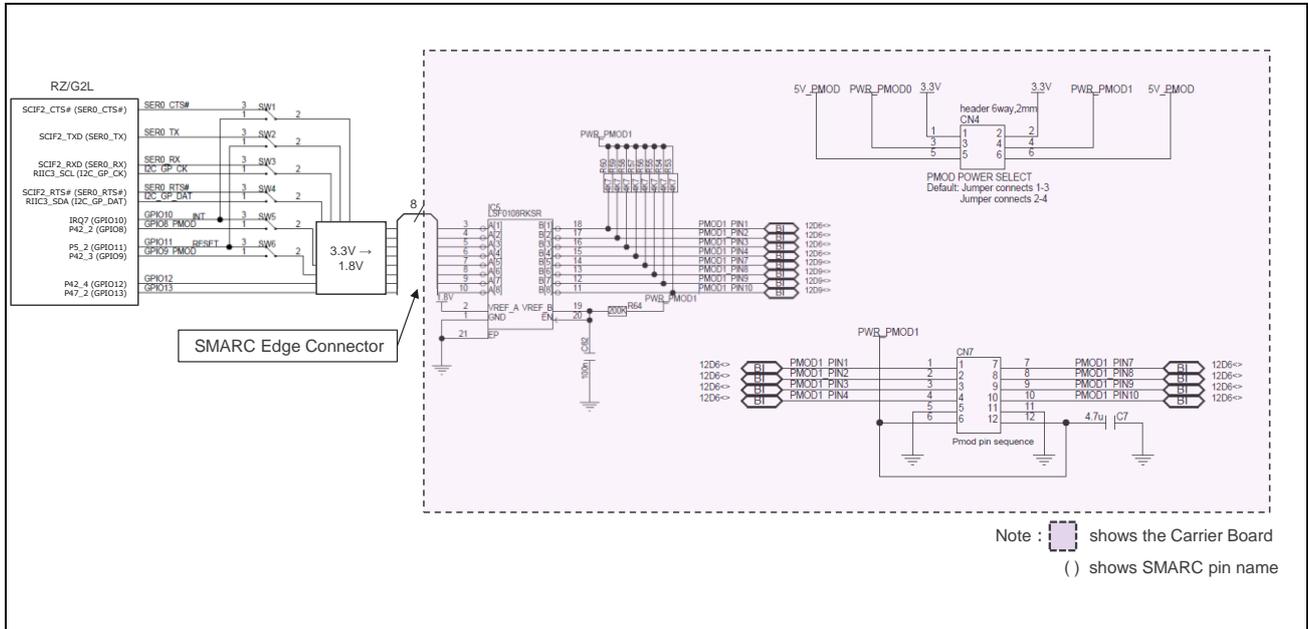


Figure 2.16 Block Diagram of PMOD1 I/F

### 3. Operation Specifications

#### 3.1 Overview of Connectors

Figure 3.1 Illustrates the layout of connectors of the RTK97X4XXXB00000BE.

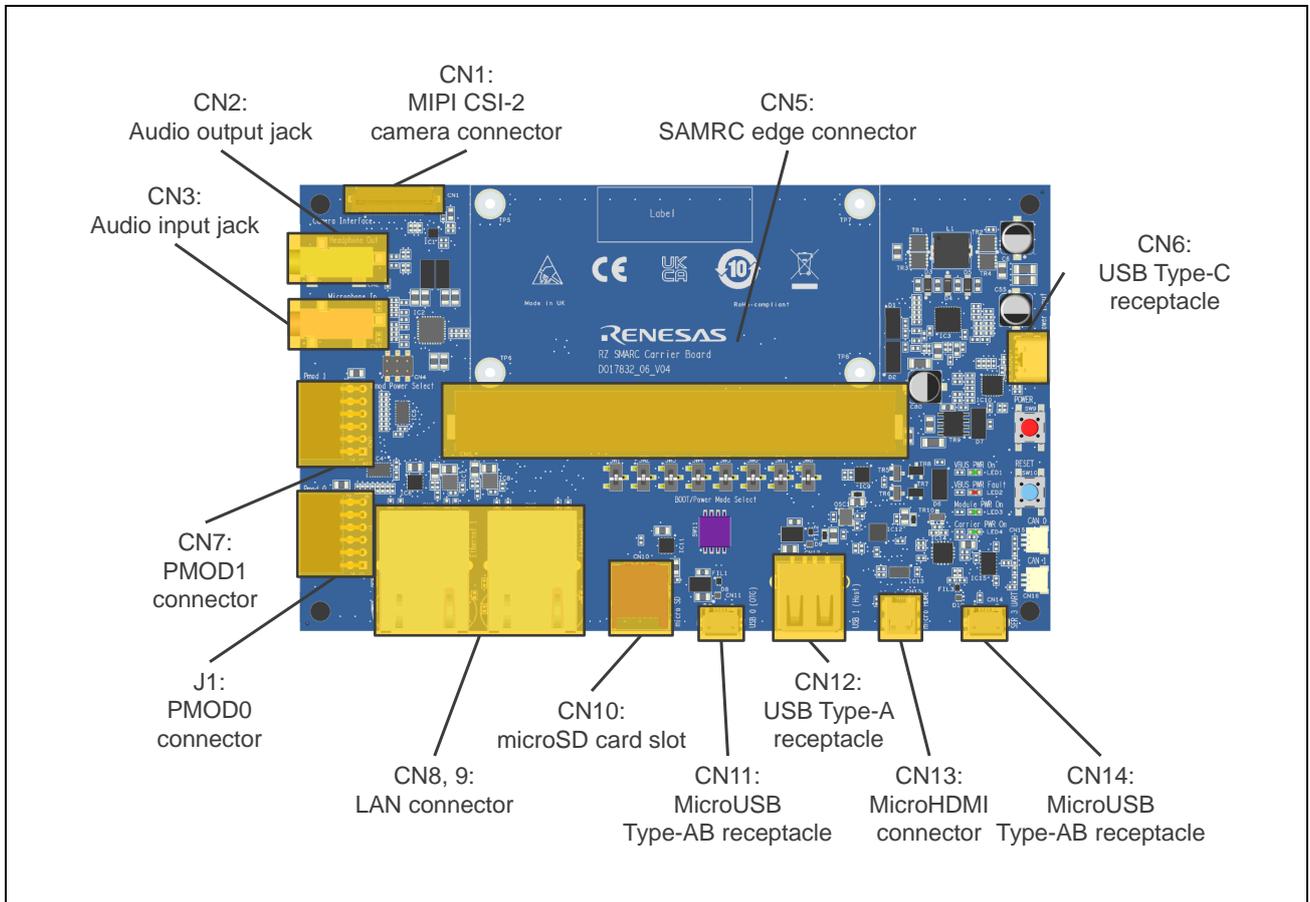


Figure 3.1 Layout of connectors of the RTK97X4XXXB00000BE (Top side)

### 3.1.1 MIPI CSI-2 Camera Connector (CN1)

The RTK97X4XXXB00000BE contains a Camera Connector (CN1).

**Figure 3.2** illustrates the layout of Camera Connector pins. **Table 3.1** shows the assignment of Camera Connector pins.

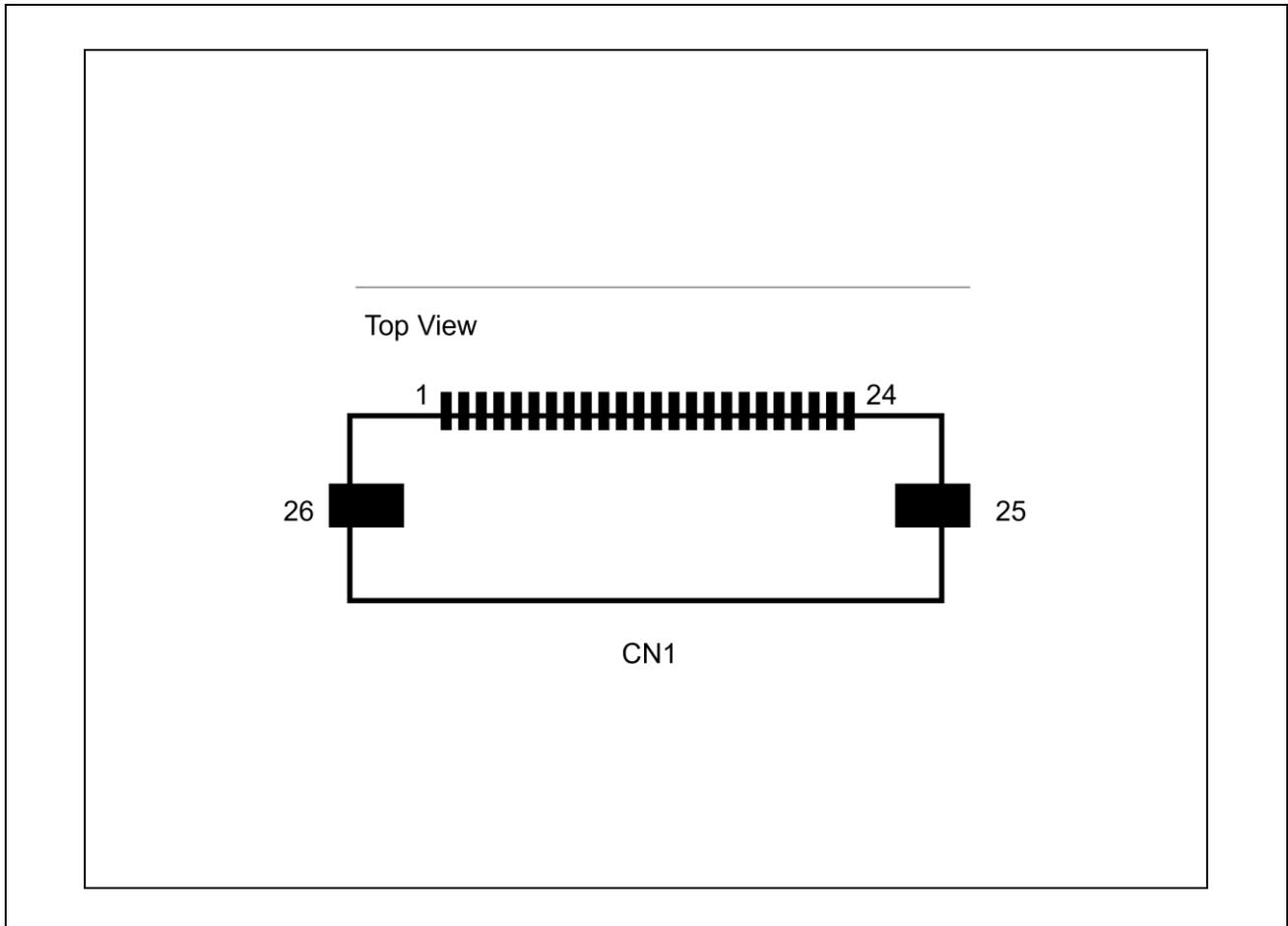


Figure 3.2 Camera Connector (CN1) Pin Layout Diagram

Table 3.1 Camera Connector (CN1) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | GND         |
| 2   | CSI1_RX0-   |
| 3   | CSI1_RX0+   |
| 4   | GND         |
| 5   | CSI1_CK-    |
| 6   | CSI1_CK+    |
| 7   | GND         |
| 8   | CSI1_RX1-   |
| 9   | CSI1_RX1+   |
| 10  | GND         |
| 11  | CSI1_RX2-   |
| 12  | CSI1_RX2+   |
| 13  | GND         |
| 14  | CSI1_RX3-   |
| 15  | CSI1_RX3+   |
| 16  | GND         |
| 17  | CAM_PWDNB   |
| 18  | —           |
| 19  | GND         |
| 20  | CAM_I2C_SCL |
| 21  | CAM_I2C_SDA |
| 22  | —           |
| 23  | CAM_RESETB  |
| 24  | 3.3V        |
| 25  | GND         |
| 26  | GND         |

### 3.1.2 Audio Output Jack (CN2)

The RTK97X4XXXB00000BE contains an Audio Output Jack (CN2).

**Figure 3.3** illustrates the layout of Audio Output Jack pins. **Table 3.2** shows the assignment of Audio Output Jack pins.

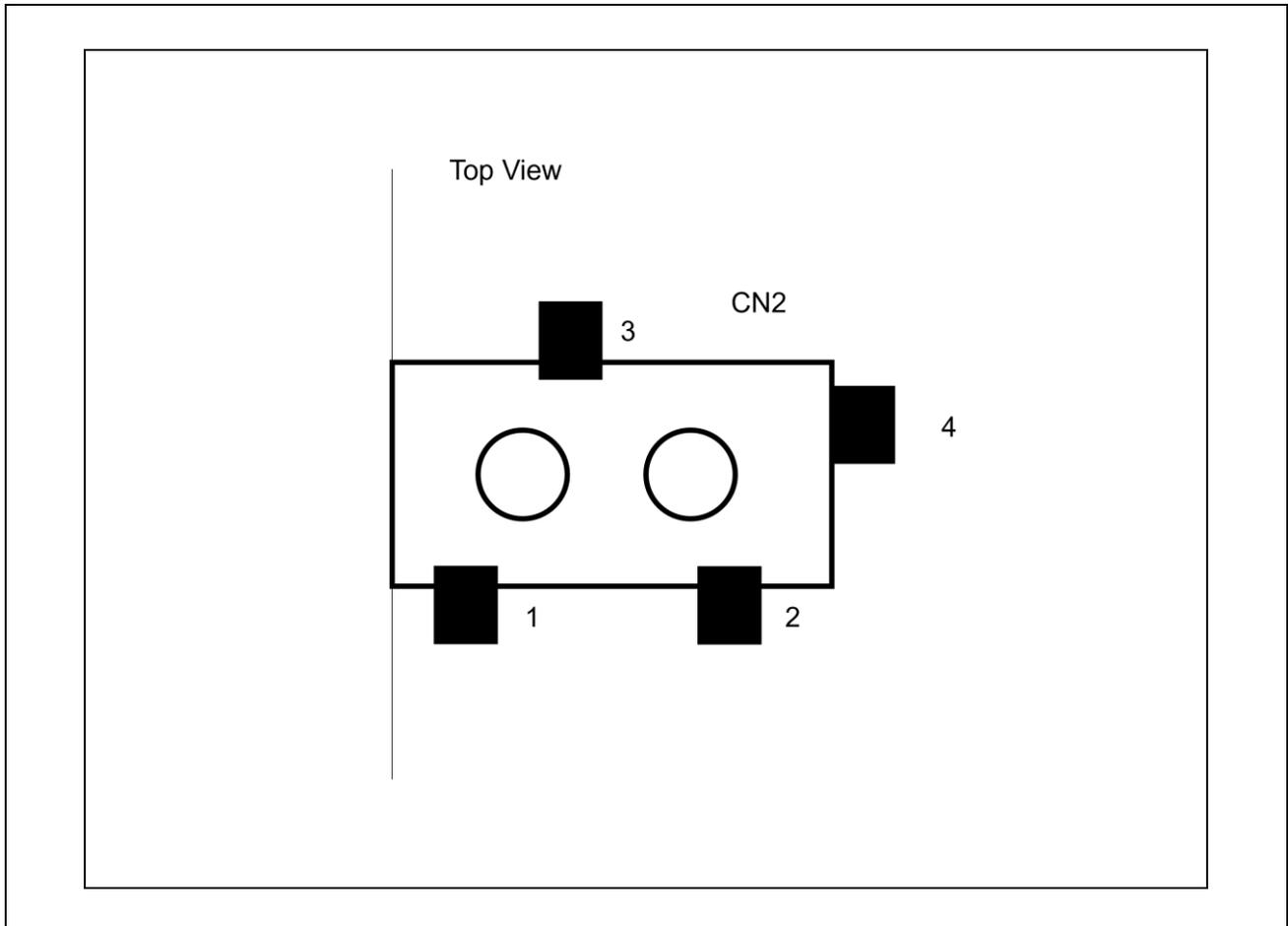


Figure 3.3 Audio Output Jack (CN2) Layout Diagram

Table 3.2 Audio Output Jack (CN2) Layout Table

| Pin | Signal Name                                     |
|-----|---|
| 1   | GND   |
| 2   | LOUT (Audio Codec Lch analog output pin)        |
| 3   | ROUT (Audio Codec Rch analog output pin)        |
| 4   | CSB/GPIO (3-Wire Control Interface Chip Select) |

### 3.1.3 Audio Input Jack (CN3)

The RTK97X4XXXB00000BE contains an Audio Input Jack (CN3).

**Figure 3.4** illustrates the layout of Audio Input Jack pins. **Table 3.3** shows the assignment of Audio Input Jack pins. Pin3 and Pin4 are also connected to MICBIAS terminal.

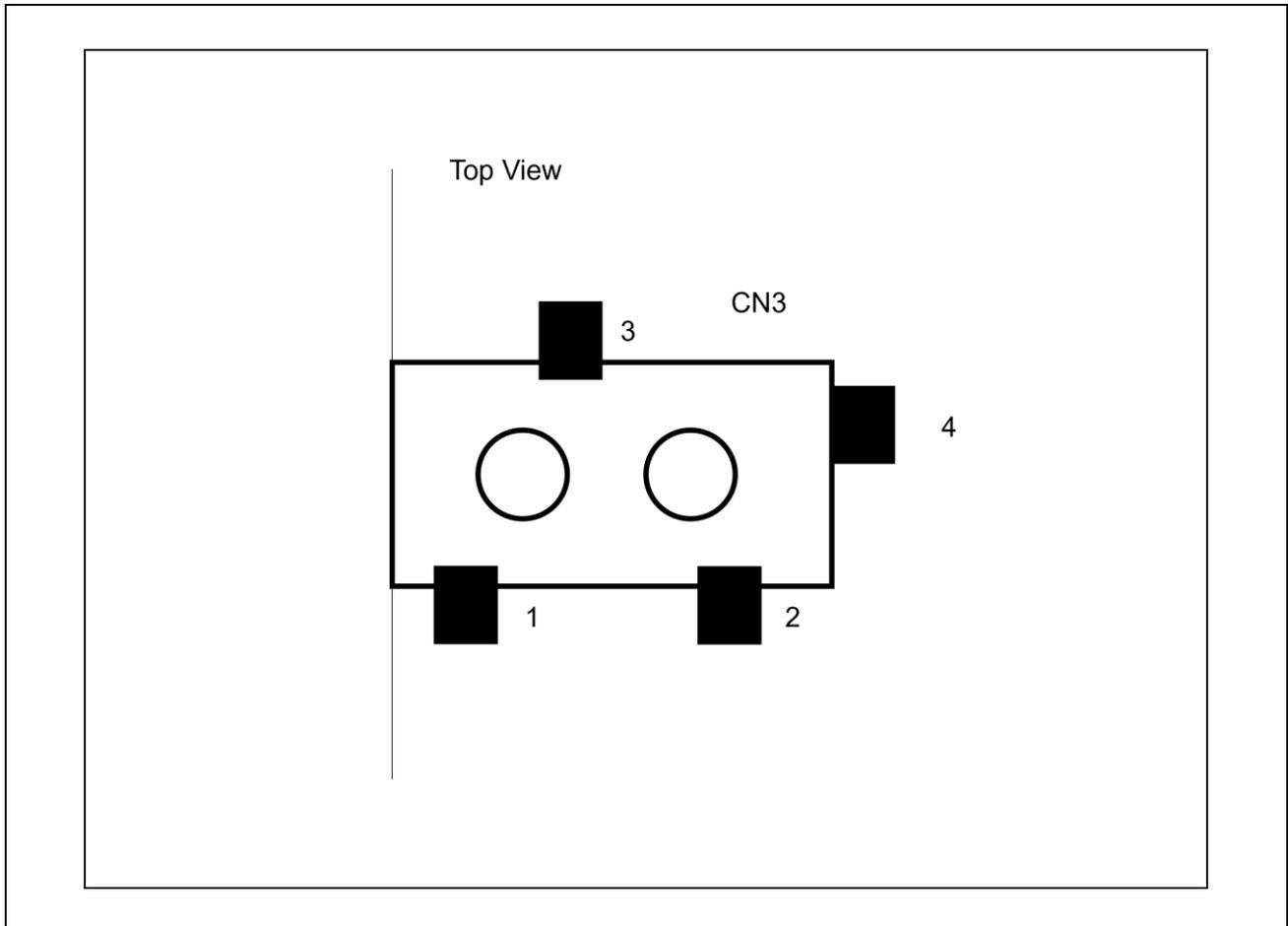


Figure 3.4 Layout of Audio Input Jack (CN3) Layout Diagram

Table 3.3 Audio Input Jack (CN3) Layout Table

| Pin | Signal Name                           |
|-----|---------------------------------------|
| 1   | GND                                   |
| 2   | L2 (Audio Codec Lch analog input pin) |
| 3   | R2 (Audio Codec Rch analog input pin) |
| 4   | —                                     |

### 3.1.4 USB Type-C Receptacle

The RTK97X4XXXB00000BE contains a USB Type-C Receptacle (CN6).

**Figure 3.5** illustrates the layout of USB Type-C Receptacle pins. **Table 3.4** shows the assignment of USB Type-C Receptacle pins.

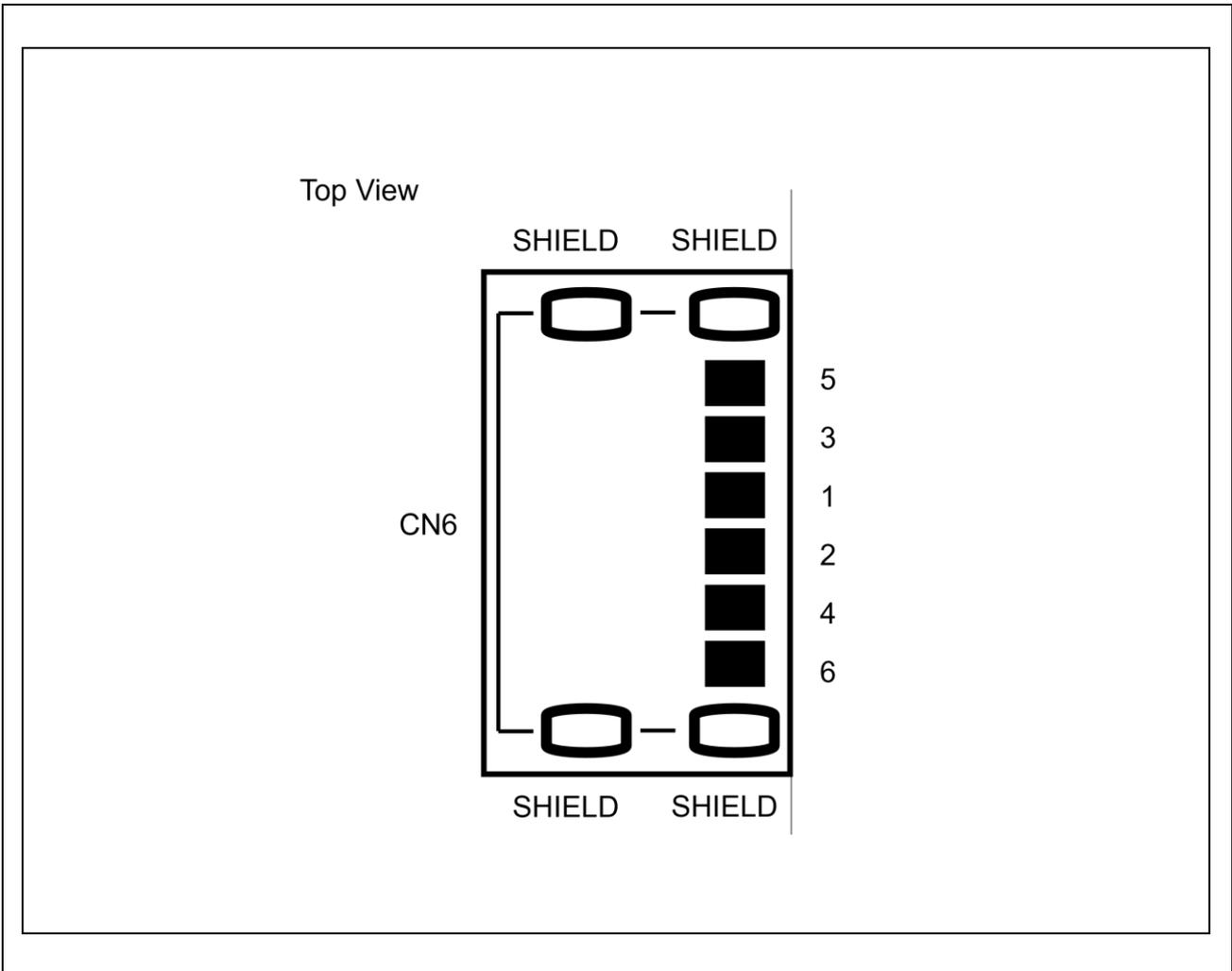


Figure 3.5 USB Type-C Receptacle (CN6) Pin Layout Diagram

Table 3.4 USB Type-C Receptacle (CN6) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | CC1         |
| 2   | CC2         |
| 3   | VBUS        |
| 4   | VBUS        |
| 5   | GND         |
| 6   | GND         |

### 3.1.5 PMOD0/1 Connector (J1, CN7)

The RTK97X4XXXB00000BE contains a PMOD0/1 connector (J1, CN7).

**Figure 3.6** illustrates the layout of PMOD0 connector pins. **Table 3.5** shows the assignment of PMOD0 connector pins.

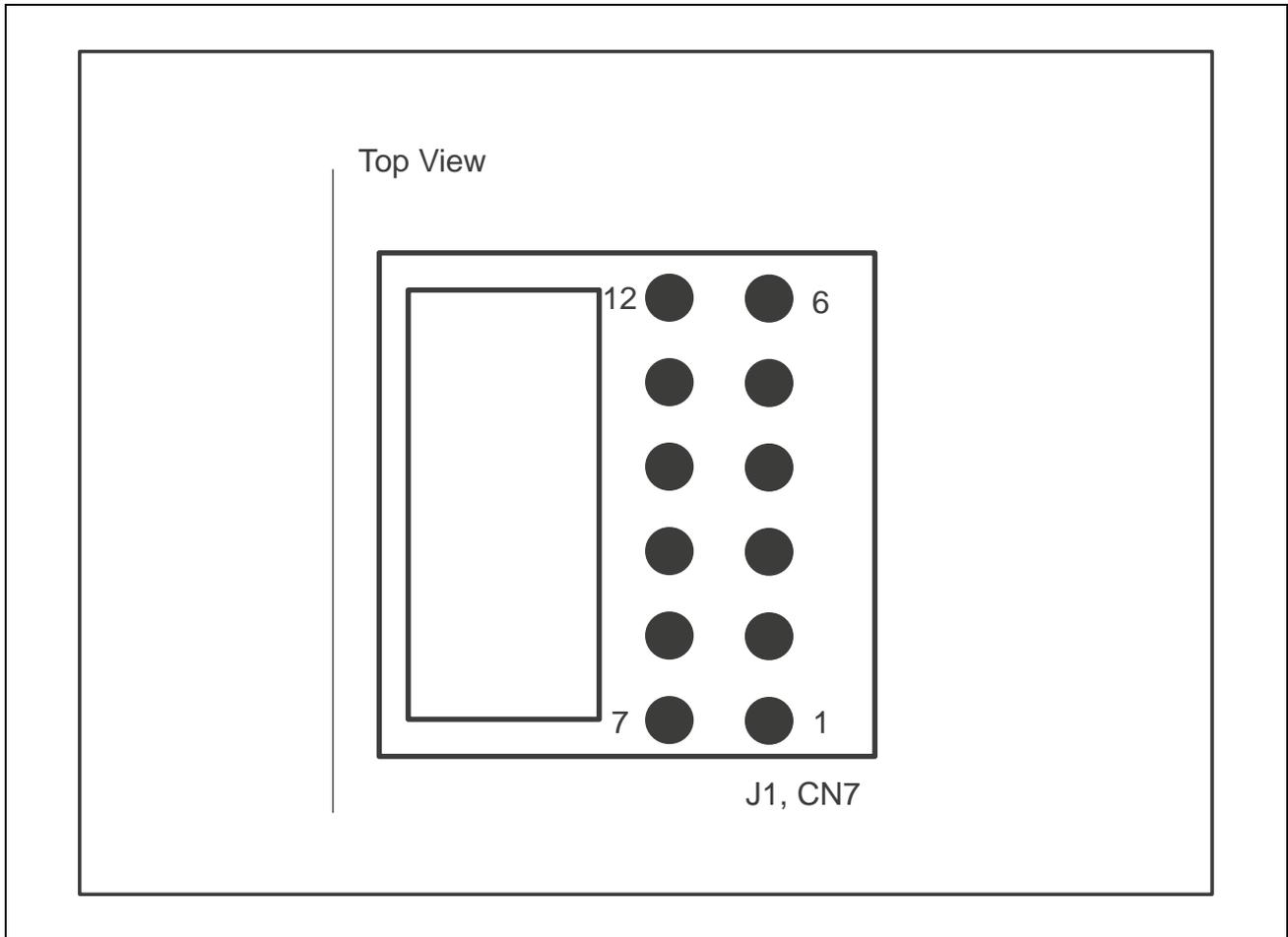


Figure 3.6 PMOD0 Connector (J1, CN7) Pin Layout Diagram

Table 3.5 PMOD0 Connector (J1) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | SPI_CS0#    |
| 2   | SPI1_DO     |
| 3   | SPI1_DIN    |
| 4   | SPI1_CK     |
| 5   | GND         |
| 6   | PWR_PMOD0   |
| 7   | INT         |
| 8   | RESET       |
| 9   | GPIO        |
| 10  | GPIO        |
| 11  | GND         |
| 12  | PWR_PMOD0   |

**Table 3.6** shows the assignment of PMOD1 connector pins.

Table 3.6 PMOD1 Connector (CN7) Pin Layout Table

| Pin | Signal Name           |
|-----|-----------------------|
| 1   | SER_CTS#/INT          |
| 2   | SER0_TX/RESET         |
| 3   | SER0_RX/I2C_GP_CK     |
| 4   | SER0_RTS#/I2C_GP_DATA |
| 5   | GND                   |
| 6   | PWR_PMOD1             |
| 7   | GPIO10                |
| 8   | INT/GPIO              |
| 9   | RESET/GPIO            |
| 10  | GPIO                  |
| 11  | GND                   |
| 12  | PWR_PMOD1             |

### 3.1.6 LAN0/1 Connector (CN8, CN9)

The RTK97X4XXXB00000BE contains a LAN0/1 Connector (CN8, CN9).

**Figure 3.7** illustrates the layout of LAN0/1 Connector pins. **Table 3.7** shows the assignment of LAN0 Connector pins.

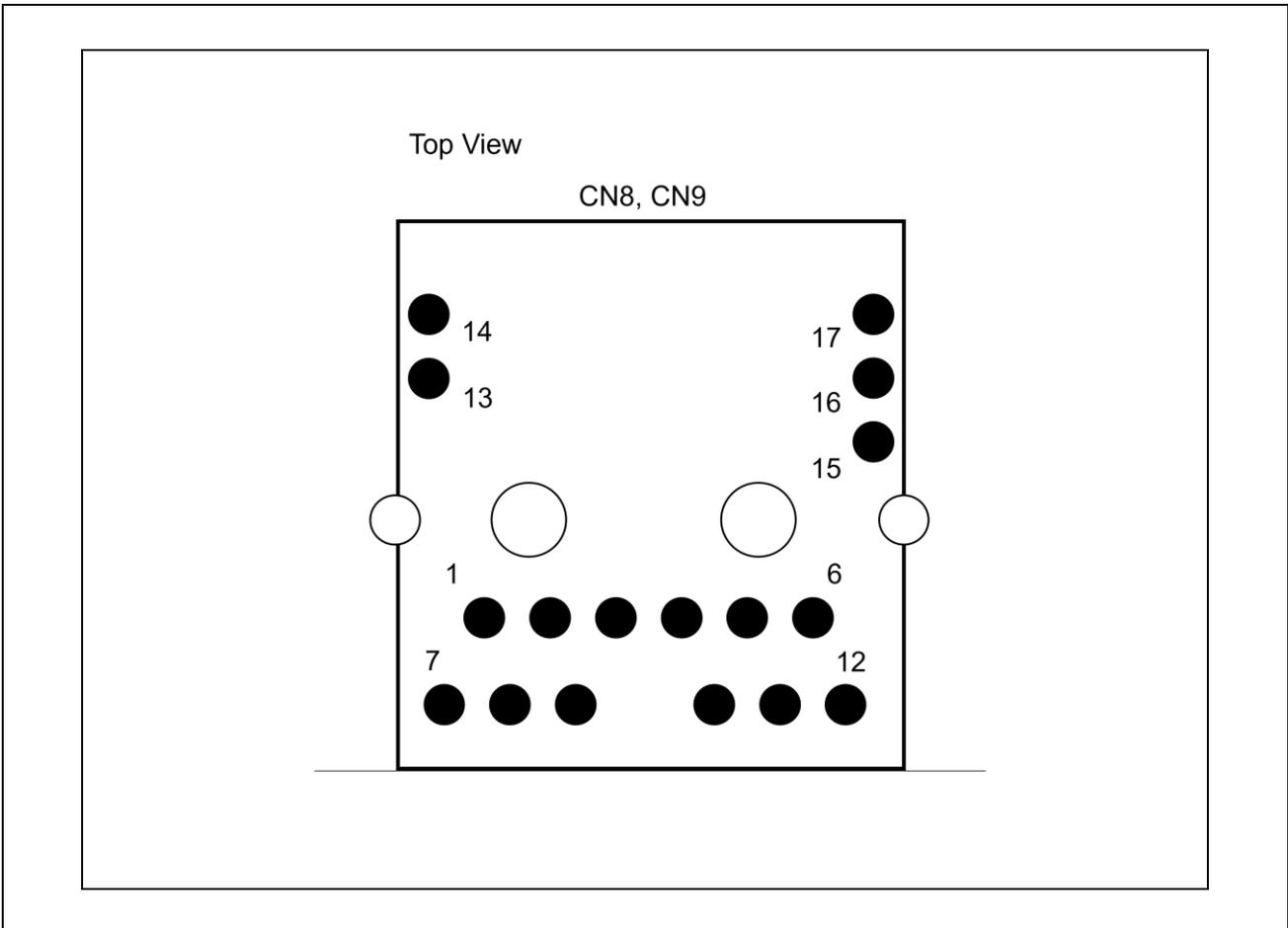


Figure 3.7 LAN Connector (CN8, CN9) Pin Layout Diagram

Table 3.7 LAN0 Connector (CN8) Pin Layout Table

| Pin | Signal Name     |
|-----|-----------------|
| 1   | GND             |
| 2   | GBE0_MDI2-      |
| 3   | GBE0_MDI2+      |
| 4   | GBE0_MDI1-      |
| 5   | GBE0_MDI1+      |
| 6   | GND             |
| 7   | GND             |
| 8   | GBE0_MDI3-      |
| 9   | GBE0_MDI3+      |
| 10  | GBE0_MDI0-      |
| 11  | GBE0_MDI0+      |
| 12  | GND             |
| 13  | GBE0_LINK_ACT#  |
| 14  | 3.3V            |
| 15  | GBE0_LINK_100#  |
| 16  | 3.3V            |
| 17  | GBE0_LINK_1000# |

**Table 3.8** shows the assignment of LAN1 Connector pins.

Table 3.8 LAN1 Connector (CN9) Pin Layout Table

| Pin | Signal Name     |
|-----|-----------------|
| 1   | GND             |
| 2   | GBE1_MDI2-      |
| 3   | GBE1_MDI2+      |
| 4   | GBE1_MDI1-      |
| 5   | GBE1_MDI1+      |
| 6   | GND             |
| 7   | GND             |
| 8   | GBE1_MDI2-      |
| 9   | GBE1_MDI2+      |
| 10  | GBE1_MDI2-      |
| 11  | GBE1_MDI2+      |
| 12  | GND             |
| 13  | GBE1_LINK_ACT#  |
| 14  | 3.3V            |
| 15  | GBE1_LINK_100#  |
| 16  | 3.3V            |
| 17  | GBE1_LINK_1000# |

### 3.1.7 microSD Card Slot (CN10)

The RTK97X4XXXB00000BE contains a microSD card slot (CN10).

**Figure 3.8** illustrates the layout of microSD card slot pins. **Table 3.9** shows the assignment of microSD card slot pins.

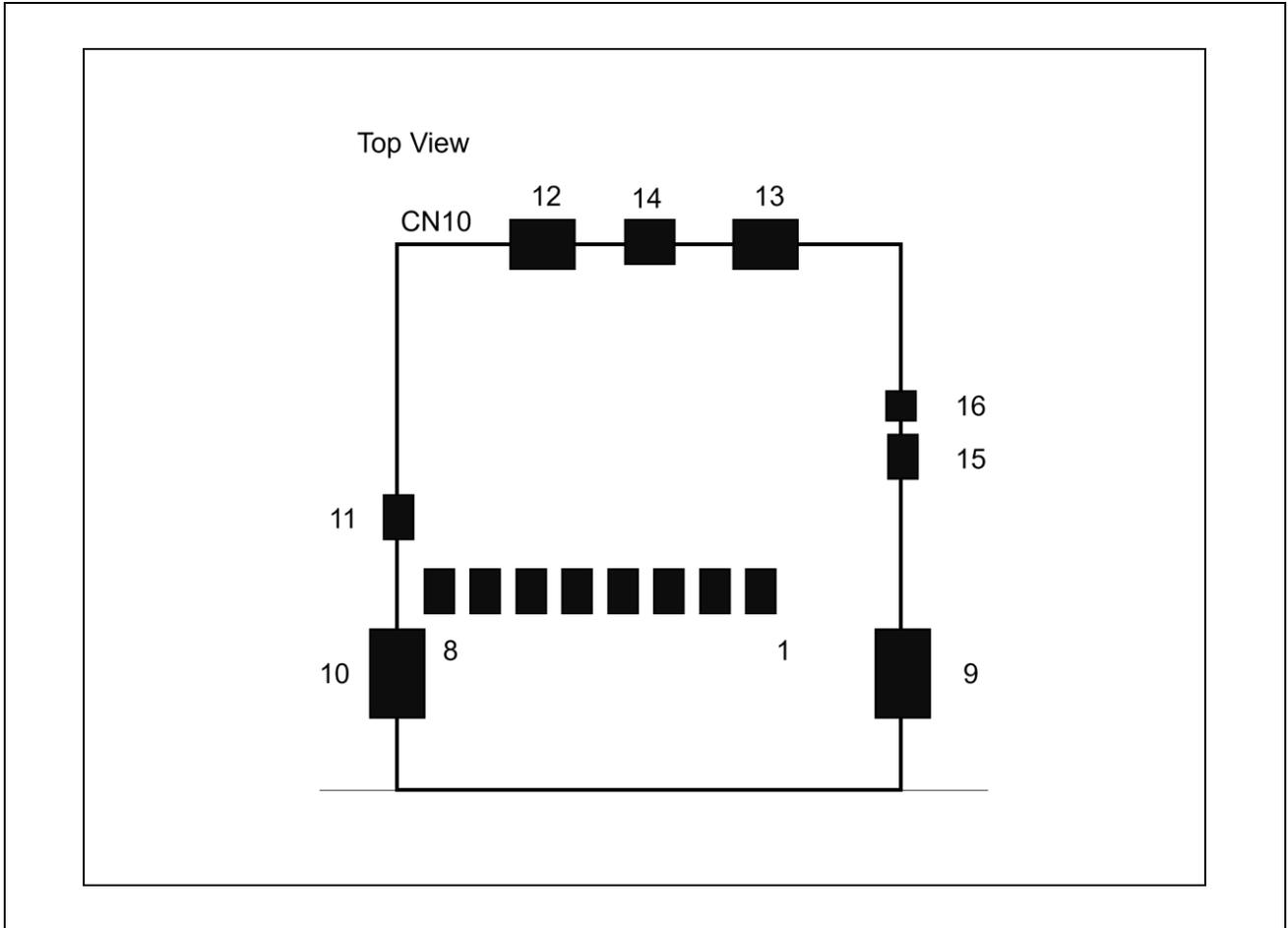


Figure 3.8 microSD Card Slot (CN10) Pin Layout Diagram

Table 3.9 microSD Card Slot (CN10) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | SDIO_D2     |
| 2   | SDIO_D3     |
| 3   | SDIO_CMD    |
| 4   | SD0_PVDD    |
| 5   | SDIO_CK     |
| 6   | GND         |
| 7   | SDIO_D0     |
| 8   | SDIO_D1     |
| 9   | SDIO_CD#    |
| 10  | GND         |
| 11  | GND         |
| 12  | GND         |
| 13  | GND         |
| 14  | GND         |
| 15  | GND         |
| 16  | GND         |

### 3.1.8 MicroUSB Type-AB Receptacle (CN11, CN14)

The RTK97X4XXXB00000BE contains a microUSB Type-AB Receptacle (CN11, CN14).

**Figure 3.9** illustrates the layout of microUSB Type-AB Receptacle pins. **Table 3.10** shows the assignment of microUSB Type-AB Receptacle pins.

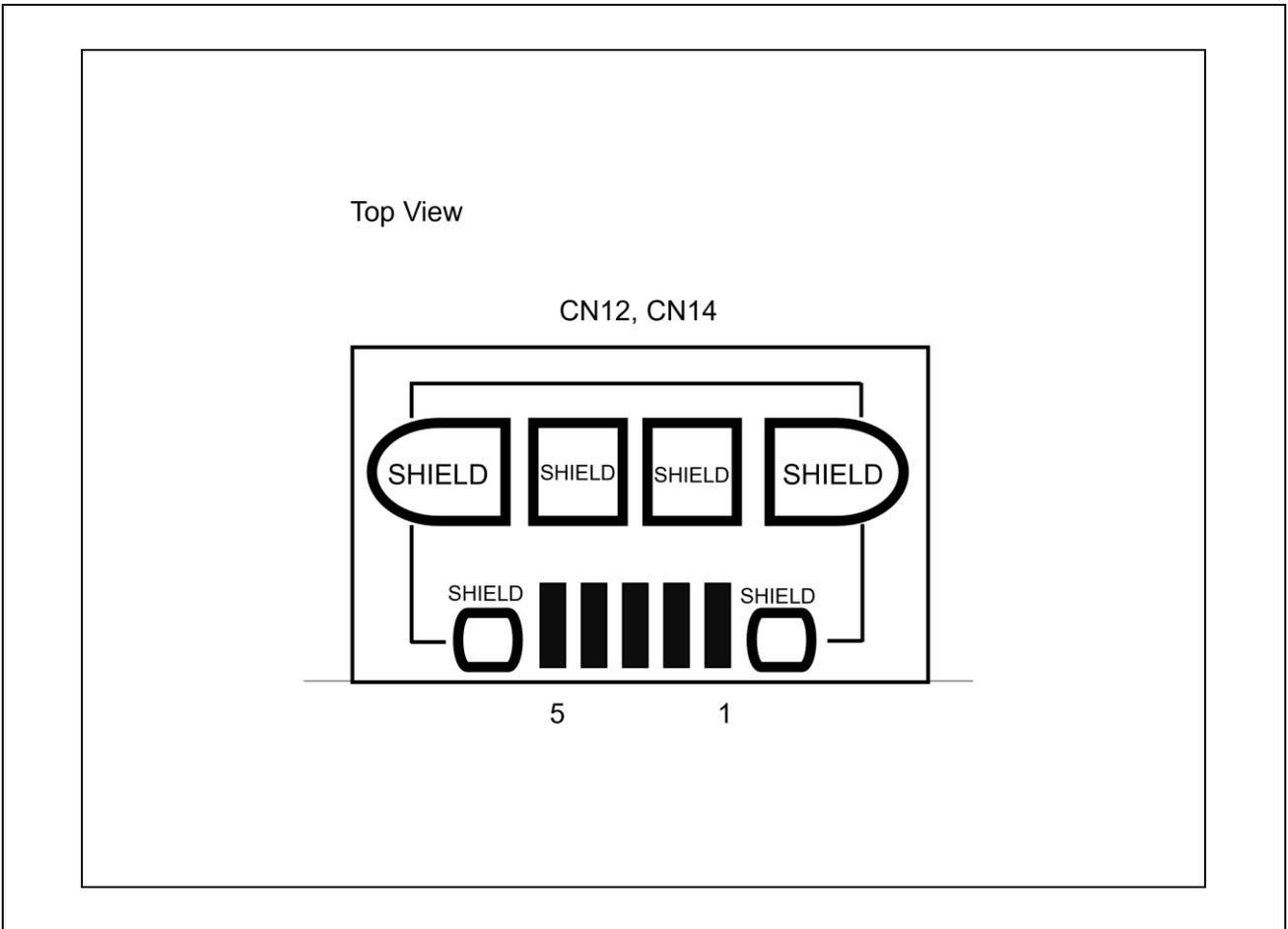


Figure 3.9 microUSB Type-AB Receptacle (CN12, CN14) Pin Layout Diagram

Table 3.10 microUSB Type-AB Receptacle (CN11) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | VBUS        |
| 2   | USB0-       |
| 3   | USB0+       |
| 4   | USB0_OTG_ID |
| 5   | GND         |

**Table 3.11** shows the assignment of microUSB Type-AB Receptacle pins.

Table 3.11 microUSB Type-AB Receptacle (CN14) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | VBUS        |
| 2   | SER3_RX     |
| 3   | SER3_TX     |
| 4   | —           |
| 5   | GND         |

### 3.1.9 USB Type-A receptacle (CN12)

The RTK97X4XXXB00000BE contains a USB Type-A Receptacle (CN12).

**Figure 3.10** illustrates the layout of USB Type-A Receptacle pins. **Table 3.12** shows the assignment of USB Type-A Receptacle pins.

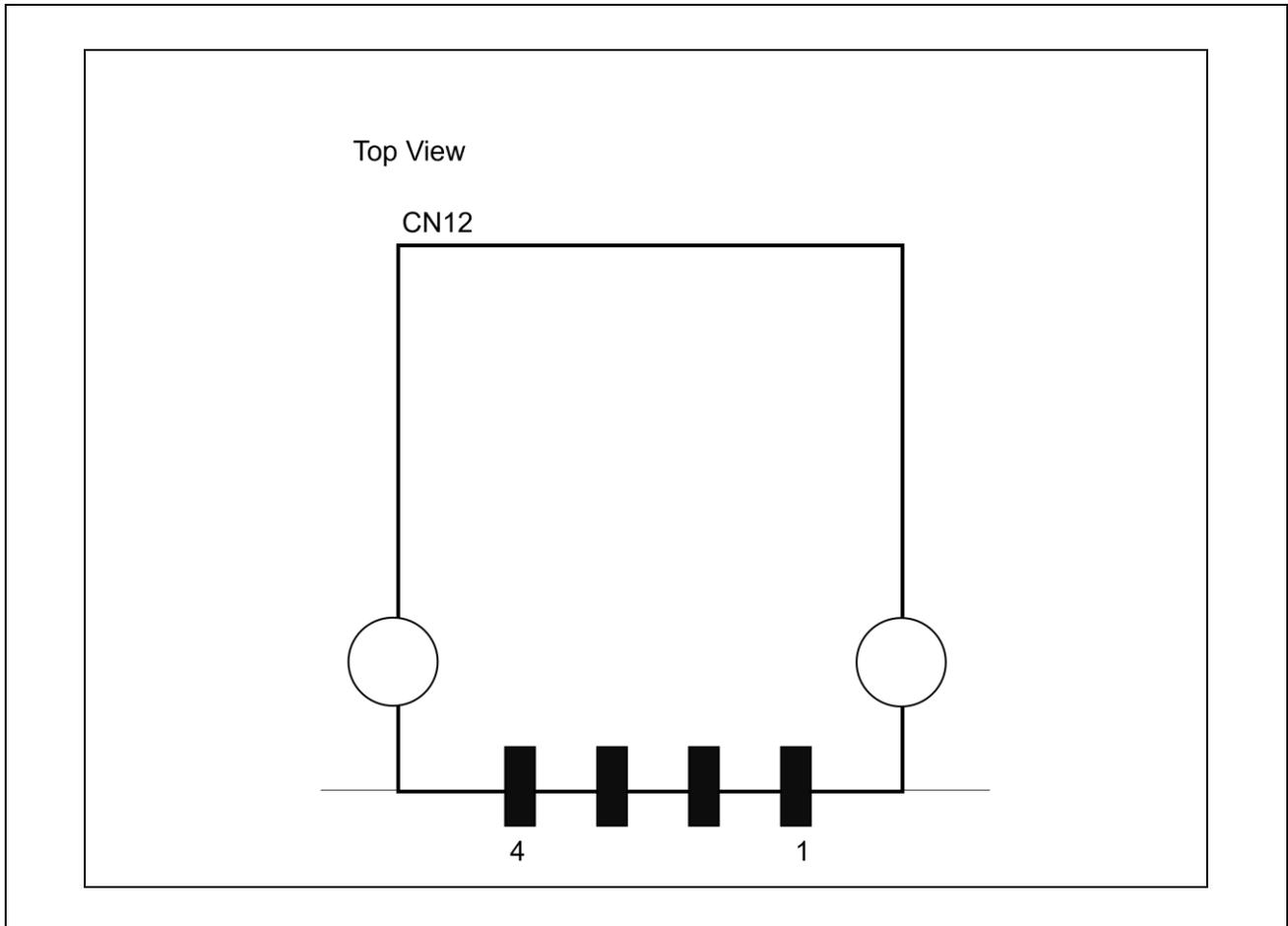


Figure 3.10 USB Type-A Receptacle (CN12) Pin Layout Diagram

Table 3.12 USB Type-A Receptacle (CN12) Pin Layout Table

| Pin | Signal Name |
|-----|-------------|
| 1   | VBUS        |
| 2   | USB1-       |
| 3   | USB1+       |
| 4   | GND         |

### 3.1.10 MicroHDMI Connector (CN13)

The RTK97X4XXXB00000BE contains a microHDMI Connector (CN13).

**Figure 3.11** illustrates the layout of microHDMI Connector pins. **Table 3.13** shows the assignment of microHDMI Connector pins.

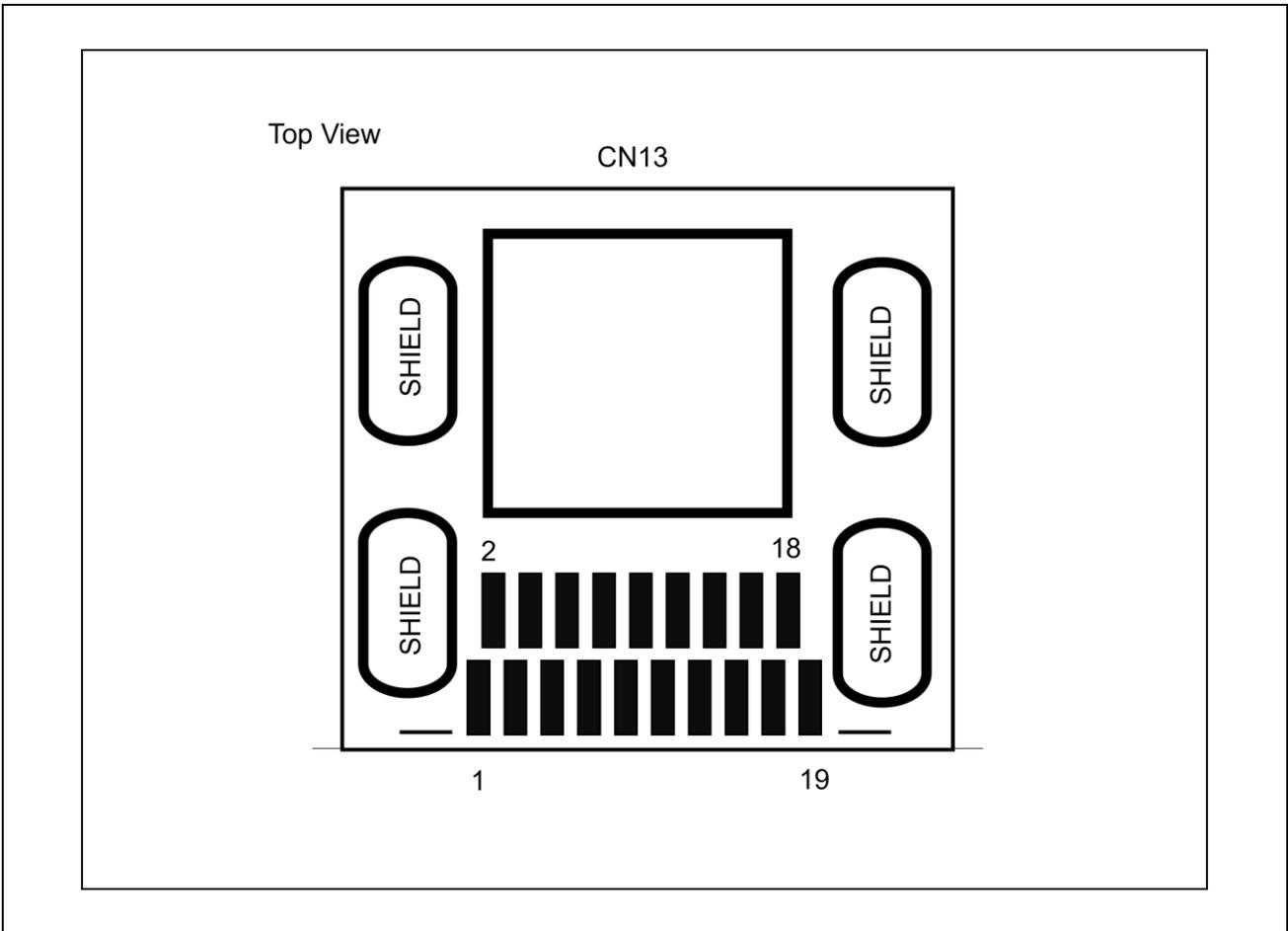


Figure 3.11 microHDMI Connector (CN13) Pin Layout Diagram

Table 3.13 microHDMI Connector (CN13) Pin Layout Table

| Pin | Signal Name           |
|-----|-----------------------|
| 1   | HDMI_HPD_3V3          |
| 2   | —                     |
| 3   | HDMI_TX2_P(DSI0_D2+)  |
| 4   | HDMI_TX2_N(DSI0_D2-)  |
| 5   | GND                   |
| 6   | HDMI_TX1_P(DSI0_D1+)  |
| 7   | GND                   |
| 8   | HDMI_TX1_N(DSI0_D1-)  |
| 9   | HDMI_TX0_P(DSI0_D0+)  |
| 10  | GND                   |
| 11  | HDMI_TX0_N(DSI0_D0-)  |
| 12  | HDMI_TXC_P(DSI0_CLK+) |
| 13  | GND                   |
| 14  | HDMI_TXC_N(DSI0_CLK-) |
| 15  | HDMI_CEC              |
| 16  | GND                   |
| 17  | DCD_SCL(I2C_LCD_CK)   |
| 18  | DCD_SDA(I2C_LCD_DAT)  |
| 19  | HDMI_5V               |

### 3.1.11 Not available

### 3.1.12 SMARC edge Connector (CN5)

The RTK97X4XXXB00000BE can be connected to an external expansion board through the Module board connecting connector (CN5).

**Figure 3.13** illustrates the layout of Carrier board connecting connector pins. For the assignment of Carrier board connecting connector pins, please refer to the section4 “MODULE PIN-OUT MAP” of the document “SMARC module 2.1 Specification (sgnet.org)”.

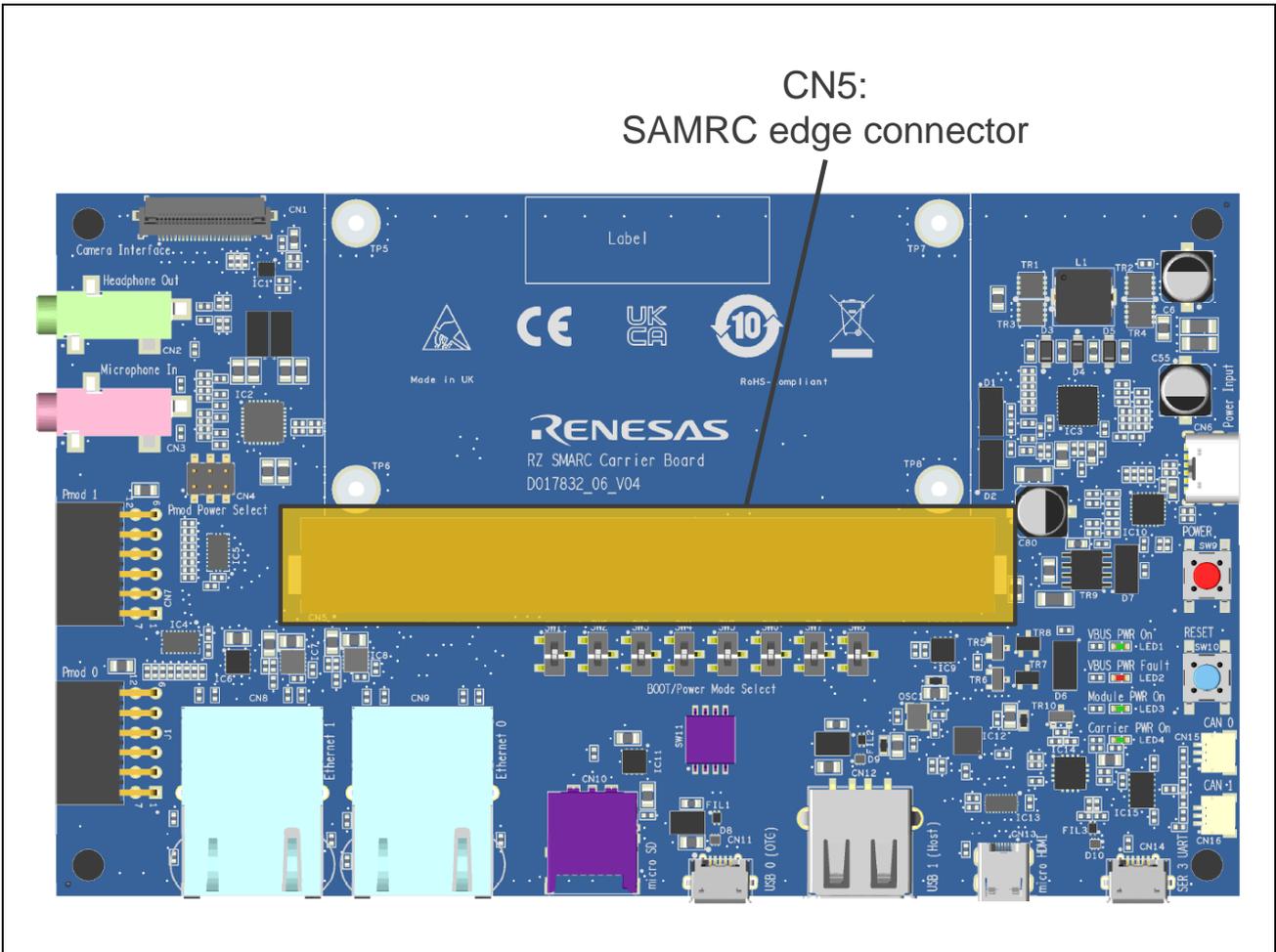


Figure 3.13 Layout of Carrier Board Connecting Pins

### 3.2 Layout of Operation Components

Figure 3.14 illustrates the layout of operation components of the RTK97X4XXXB00000BE.

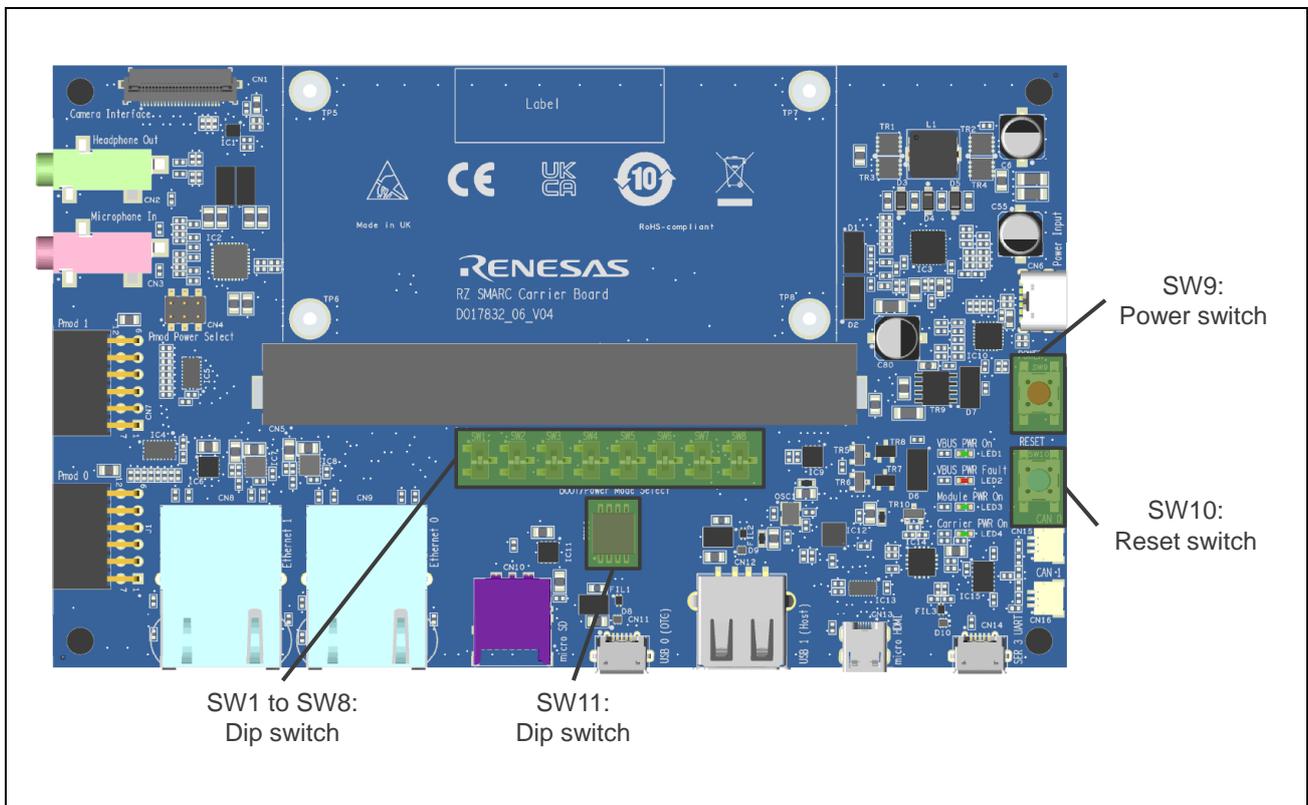


Figure 3.14 Layout of Operation Components of the RTK97X4XXXB00000BE

### 3.2.1 Functions of Switches and Mode Terminals

The RTK97X4XXXB00000BE contains one switch.

**Table 3.16** lists mounted switches. **Table 3.17** provides functions of the DIP switch.

Table 3.16 Switches Mounted on the RTK97X4XXXB00000BE

| No.  | Function                     | Note                                     |
|------|------------------------------|--|
| SW1  | System setting DIP switch    | For details, see <b>Table 3.17</b>       |
| SW2  |                              |  |
| SW3  |                              |  |
| SW4  |                              |  |
| SW5  |                              |  |
| SW6  |                              |  |
| SW7  |                              |  |
| SW8  |                              |  |
| SW9  | Power supply switch          |  |
| SW10 | Reset switch                 | Refer to <b>section 2.7</b> for details. |
| SW11 | Boot Mode setting DIP switch | For details, see <b>Table 3.18</b>       |

Table 3.17 Functions of System Setting DIP Switch (SW1 to SW8)

| No. | Setting            | Function        |
|-----|--------------------|-----------------|
| SW1 | OFF SCIF2_CTS#="H" | Used as Type-3A |
|     | ON P3_1="L"        | Used as Type-6A |
| SW2 | OFF SCIF2_TX="H"   | Used as Type-3A |
|     | ON P5_2="L"        | Used as Type-6A |
| SW3 | OFF SCIF2_RX="H"   | Used as Type-3A |
|     | ON RIIC3_SCL="L"   | Used as Type-6A |
| SW4 | OFF SCIF2_RTS="H"  | Used as Type-3A |
|     | ON RIIC3_SDA="L"   | Used as Type-6A |
| SW5 | OFF P3_1="H"       | Used as Type-3A |
|     | ON P42_2="L"       | Used as Type-6A |
| SW6 | OFF P5_2="H"       | Used as Type-3A |
|     | ON P42_3="L"       | Used as Type-6A |
| SW7 | OFF P42_2="H"      | Used as CAN0    |
|     | ON P42_2="L"       | Used as PMOD1   |
| SW8 | OFF P42_3="H"      | Used as CAN0    |
|     | ON P42_3="L"       | Used as PMOD1   |

Figure 3.15 shows a block diagram of the System Setting interface. Table 3.18 provides functions of mode terminals.

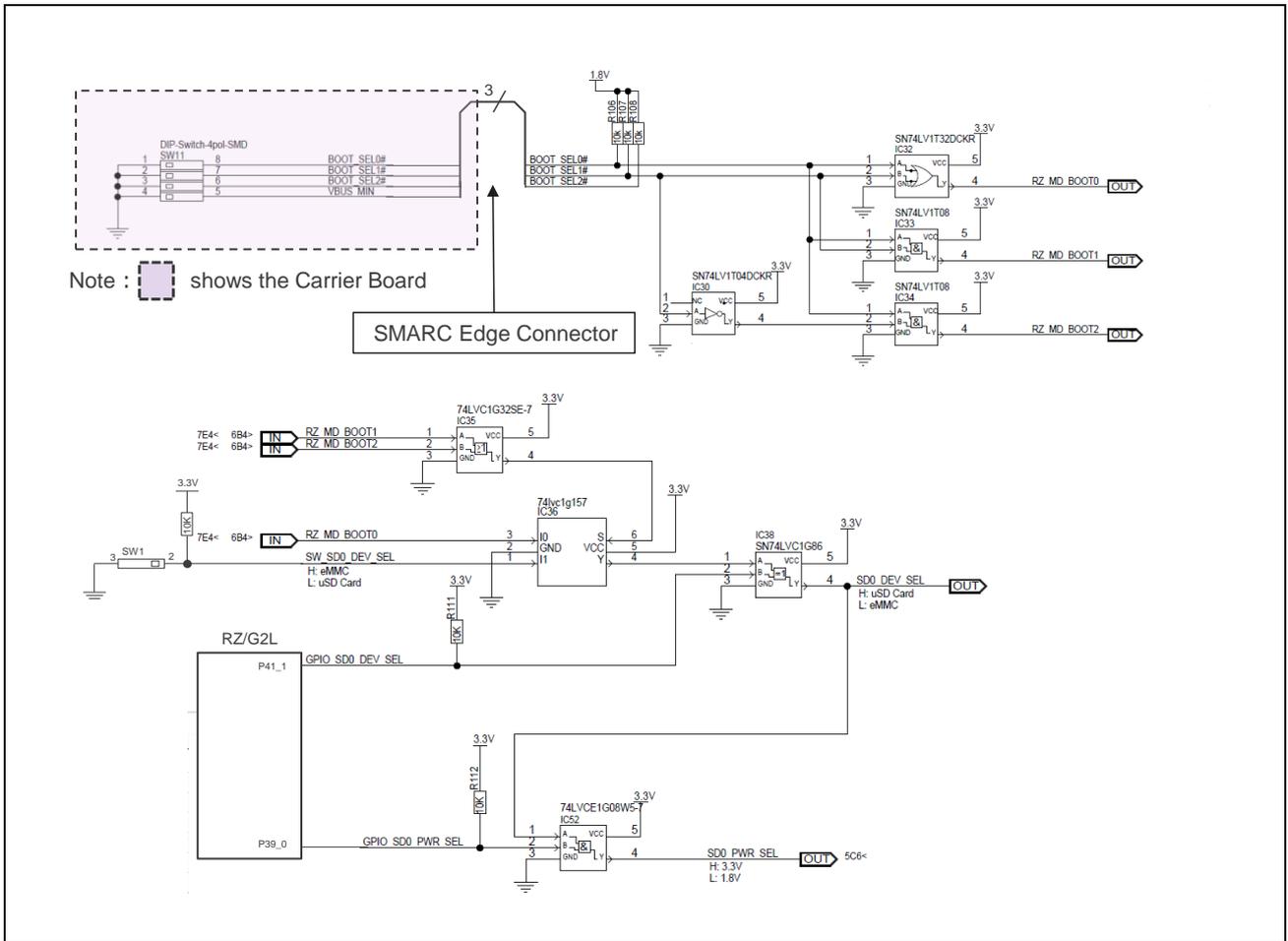


Figure 3.15 Block Diagram of System Setting I/F

Table 3.18 Functions of System Setting

| No.                          |     |     | Setting    |   |   | Function                     | Setting                              |   |   | Function  |                                   |
|------------------------------|-----|-----|------------|---|---|------------------------------|--------------------------------------|---|---|---|-----------------------------------|
| CARRIER BOOT_SEL (SW11) (*1) |     |     | RZ_MD_BOOT |   |   | Boot Mode                    | MODULE (SW1-2)<br>SW_SD0_DEV_SEL(*2) | P41_1<br>(external pull-up)<br>GPIO_SD0_DEV_SEL | P39_0<br>(external pull-up)<br>GPIO_SD0_PWR_SEL | Device connected to SD0<br>(P0_0 Read Only)<br>SD0_DEV_SEL (*3) | SD0_PVDD<br>(SD0_PWR_SEL)<br>(*4) |
| 0#                           | 1#  | 2#  | 0          | 1 | 2 |                              |                                      |   |   |   |                                   |
| Off                          | On  | On  | 0          | 0 | 0 | eSD<br>(start up 3.3V)       | x                                    | 1   | 1   | uSD Card  | 3.3V                              |
| Off                          | Off | On  | 1          | 0 | 0 | eMMC (1.8V)                  | x                                    | 1   | x   | eMMC  | 1.8V                              |
| Off                          | Off | Off | 1          | 1 | 0 | Single/Quad/<br>Octal (1.8V) | Off                                  | 1   | x   | eMMC  | 1.8V                              |
| Off                          | Off | Off | 1          | 1 | 0 | Single/Quad/<br>Octal (1.8V) | On                                   | 1   | 1   | uSD Card  | 3.3V                              |
| Off                          | On  | Off | 1          | 0 | 1 | SCIF download                | Off                                  | 1   | x   | eMMC  | 1.8V                              |
| Off                          | On  | Off | 1          | 0 | 1 | SCIF download                | On                                   | 1   | 1   | uSD Card  | 3.3V                              |

Note: "x" means that it does not depend on the DIP SW setting.

Note 1. "On" of "BOOT\_SEL0#", "BOOT\_SEL1#" and "BOOT\_SEL2#" signal means 0(="H").  
"Off" means 1(="L").

Note 2. "On" of "SW\_SD0\_DEV\_SEL" signal means to connect microSD card(="H").  
"Off" means to connect eMMC memory(="L").

Note 3. "On" of "SD0\_DEV\_SEL" signal means to connect eMMC memory(="H").  
"Off" means to connect microSD card(="L").

Note 4. "On" of "SD0\_PWR\_SEL" signal means to supply 1.8V(="H").  
"Off" means to supply 3.3V(="L").

### 3.2.2 Functions of LEDs

The RTK97X4XXXB00000BE contains four LEDs.

Figure 3.16 illustrates the layout of LEDs. Table 3.19 lists mounted LEDs.

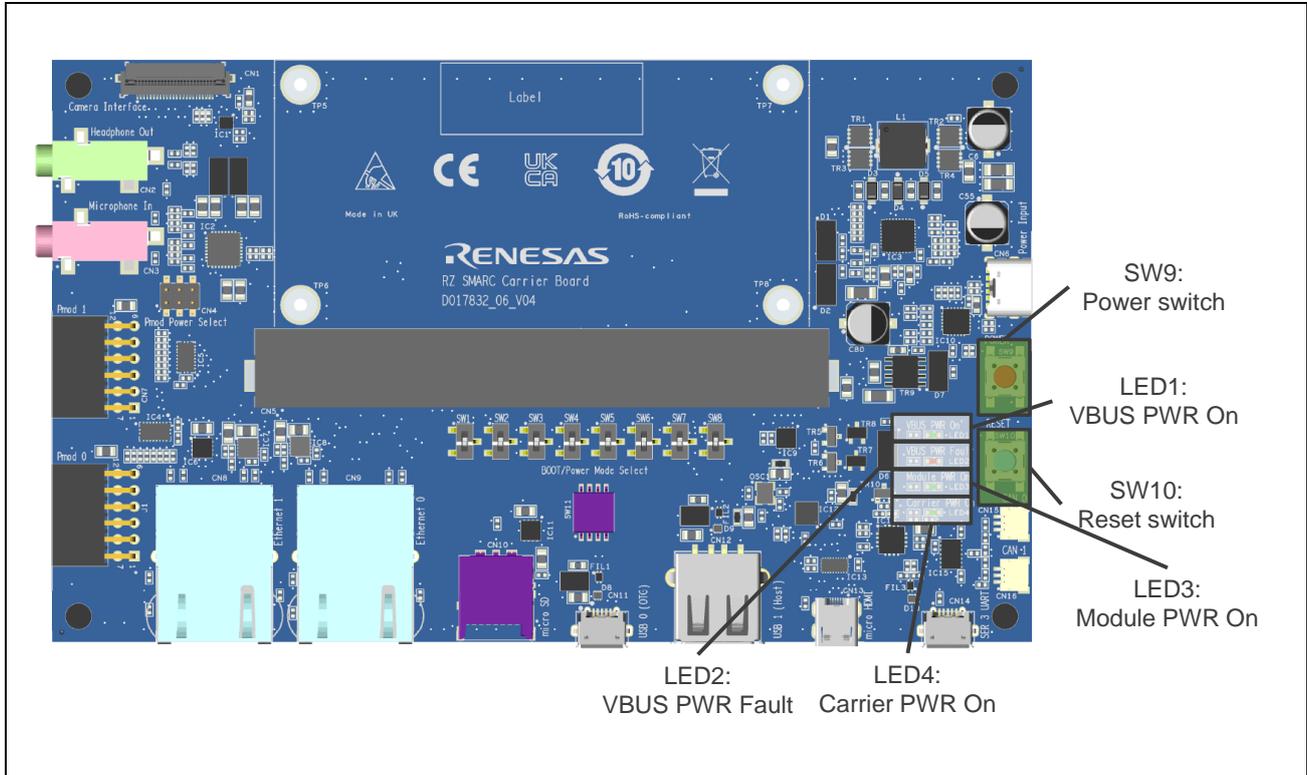


Figure 3.16 Layout of LEDS Mounted on the RTK97X4XXXB00000BE

Table 3.19 LEDs Mounted on the RTK97X4XXXB00000BE

| No.  | Color | Function                                   |
|------|-------|--|
| LED1 | Green | VBUS PWR On (Lit while 5V is supplied)     |
| LED2 | Green | VBUS PWR Fault                             |
| LED3 | Green | Module PWR On (Lit while 5V is supplied)   |
| LED4 | Green | Carrier PWR On (Lit while SW9 is 57ressed) |

|                  |  |
|------------------|--|
| REVISION HISTORY | RZ Family / RZ/G, RZ/V, RZ/A Series<br>RZ SMARC Series Carrier Board |
|------------------|--|

| Rev. | Date         | Description                      |   |
|------|--------------|----------------------------------|---|
|      |              | Page                             | Summary   |
| 1.00 | Sep 27, 2021 | —                                | First edition issued  |
| 1.01 | Oct 07, 2021 | 1                                | For front cover, it is changed the description from "RZ SMARC Series Carrier Board RTK97X4XXXB00000BE" to "RZ SMARC Series Carrier Board".<br>It is changed from "RZ Family / RZ/G Series" to "RZ Family / RZ/G, RZ/V Series"   |
|      |              | 7                                | For Tyle, it is changed the description from "RZ Family / RZ/G Series RZ SMARC Series Carrier Board RTK97X4XXXB00000BE" to "RZ Family / RZ/G, RZ/V Series RZ SMARC Series Carrier Board".   |
|      |              | 8                                | For section "Configuration", it is added the description "RTK9754L23C01000BE(RZ/V2L SMARC Module Board)".   |
|      |              | 17                               | For section "MPU", it is added the description "Please refer to the function list (section 2.2.2) in the user's manual of each module board".<br>For section "Overview of RZ/G2L", it is removed the description.<br>For section "List of RZ/G2L functions", it is removed the description. |
|      |              | 58                               | For Revision History, it is changed the description from "RZ Family / RZ/G Series RZ SMARC Series Carrier Board RTK97X4XXXB00000BE" to "RZ Family / RZ/G, RZ/V Series RZ SMARC Series Carrier Board".   |
|      |              | 60                               | For back cover, it is changed the description from "RZ Family / RZ/G Series" to "RZ Family / RZ/G, RZ/V Series".  |
| 1.02 | Feb 15, 2022 | 8                                | The RTK9743U11C01000BE (RZ/G2UL SMARC Module Board) is added.   |
| 1.03 | Mar 7, 2022  | 8                                | The RTK9743F01C01000BE (RZ/Five SMARC Module Board) is added.   |
| 1.04 | Apr 26, 2022 | 8                                | The RTK9763U02C01000BE (RZ/A3UL SMARC Module Board QSPI Edition) is added.<br>The RTK9763U02C01001BE (RZ/A3UL SMARC Module Board Octal Edition) is added.<br>For Figure1.1, it is changed from "RZ/V2L SMARC Module Board" to "RZ/G2L SMARC Module Board".                                  |
| 1.10 | Dec 13, 2022 | 7, 9, 10, 13, 15, 17, 31, 34, 51 | CAN-FD interface is not supported because a CAN transceiver is not fitted.  |
|      |              | 29                               | For section "Camera Interface", it is added a note on the use of camera modules.  |
|      |              | 40                               | For section "PMOD0/1 Connector (J1, CN7)", Figure 3.6 is modified.  |
| 1.20 | Mar 22, 2024 | 17, 31                           | For section 2.13 "CAN-FD Interface", CAN-FD Interface is supported.   |
|      |              | 24                               | For section 2.7 "Reset Control", figure is modified.  |
|      |              | 25                               | For section 2.8 "Power Supply Configuration", figure is modied.   |
|      |              | 32, 33                           | For section 2.14 "PMOD Interface", figure is modified.  |
| 1.21 | Mar 27, 2024 | 24                               | For section 2.7 "Reset Control", figure is modified.  |

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RZ Family / RZ/G, RZ/V, RZ/A Series User's Manual: Hardware

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# RZ Family / RZ/G, RZ/V, RZ/A Series